



Automotive

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FREESCALE SEMICONDUCTOR ANALOG AND MIXED-SIGNAL PRODUCTS

The product categories range from Power Actuation and Communication Transceivers to Signal Conditioning and Embedded MCU + Power. Power Actuation covers a broad range of load control and drivers, including motor control.

SMARTMOS™ — Freescale Semiconductor SMARTMOS technology allows designers to interface high-precision components with the harsh automotive environment.

Cost-Effective — Ideally suited for rugged automotive applications, SMARTMOS solutions offer a cost-effective blend of analog, digital, and robust power silicon that enables integrated, mixed-signal, power control ICs.

Functionality — SMARTMOS solutions implement traditional analog functions with smaller die size, and a modular process produces components with the minimum number of process steps for each circuit, minimizing overhead.

Benefits — Freescale Semiconductor SMARTMOS technology brings a wide range of benefits to today's designs, including component reductions, power flexibility, durability, efficiency, precision, high-performance analog, and robustness.

Packaging — Freescale devices may be offered in EPP and RoHS compliant packages.

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ANALOG AND MIXED-SIGNAL PRODUCTS

Power Actuation — Low-Side Switches (Solid State Intelligent Switches)

Product	Description	No of Outputs	High-Side or Low-Side	Continuous Current Each Output (A)	R _{DS(on)} (mΩ) of Each Output	Current Limitation (A)	Current Limitation Standby Max (μA)	Control ¹	Status/Fault Reporting	Protection Features	Packaging	Status
MC33800	Engine Control IC, with Eight Low-Side Switches, Two Constant Current Low-Side Switches and Six MOSFET gate pre-drivers	8	L	8 @ 0.35	2 @ 700 6 @ 1000	2 @ 6.0 6 @ 2.0	30	SPI, Parallel	SPI	Open Load detect, Overcurrent protect, Overvoltage protect, Shorted Load detect, Undervoltage protect, Thermal protect	54-pin SOICW Exposed Pad	Production EVB
MC33810	Engine Control Integrated Circuit capable of driving a combination of four Low-Side loads and four MOSFETs or IGBT gates	4	L	1.0	100	6.0	30	SPI, Parallel	SPI Status Flags	Shorted Load detect, Thermal protect	32-pin SOICW Exposed Pad	Production EVB
MC33812	Engine control power IC, with 3 Low-Side drivers, one pre-driver, +5V pre-regulator, ISO-9141 physical interface and MCU watchdog circuit.	3	L	2 @ 4.0 1 @ 1.5	2 @ 200 1 @ 1000	2 @ 6.0 1 @ 2.0	2 @ 1000 1 @ 20	Parallel	Parallel	Overcurrent, Outputs Short to Battery, Overtemperature Protect	32-pin SOICW Exposed Pad	Production EVB Ref.Dsgn.
MC33879	(1.0 Ω R _{DS(on)}) Configurable Eight Output SPI Controlled Switch	8	H/L	0.35	550	1.2	25	SPI w/ 2 PWM	SPI	Short Circuit, Current Limit, Temp Sense	32-pin SOICW Exposed Pad	Production EVB
MC33882	(0.8 Ω RDS(on)) Smart Six Output Switch with SPI and Parallel Input Control	8	L	1.0	375	3.0	10	SPI	SPI	Short Circuit, Current Limit, Temp Sense	30-pin HSOP, 32-pin SOICW Exposed Pad, 32-pin QFN Exposed Pad	Production
MC33996	16 Output Hardware Low-Side Switch with 24-Bit Serial Input Control	16	L	0.5	450	1.0 to 2.5	50	SPI	SPI	Short Circuit, Current Limit, Temp Sense, Open Load	32-pin SOICW	Production EVB
MC33999	16 Output Hardware Low-Side Switch with 24-Bit Serial Input Control and 8 Parallel Control	16	L	0.5	450	1.0 to 2.5	50	SPI, Parallel	SPI	Short Circuit, Current Limit, Temp Sense, Open Load	54-pin SOICW	Production EVB
MM912_634	Integrated S12 MagniV Based Relay Drivers with LIN	See Embedded MCU + Power/ S12 MagniV Mixed-Signal MCUs (page 10)										

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boards.



ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Power Actuation — High-Side Switches (Solid State Intelligent Switches)

Product	Description	No of Outputs	High-Side or Low-Side	Maximum Current Each Output (A)	$R_{DS(on)}$ (m Ω) of Each Output	Current Limitation (A)	Current Limitation Standby Max (μ A)	Control ¹	Status/Fault Reporting	Protection Features	Packaging	Status
MC33879	(1.0 Ω $R_{DS(ON)}$) Configurable Eight Output SPI Controlled Switch	8	H/L	1.2	550	1.2	25	SPI w/ 2 PWM	SPI	Short-circuit, Current Limit, Temp Sense	32-pin SOICW Exposed Pad	Production EVB
MM908E621	Integrated Quad Half-Bridge and Triple High-Side with Embedded MCU and LIN for High End Mirror	See Embedded MCU plus Power (page 11)										
MM908E622	Integrated Quad Half-Bridge, Triple High-Side and EC Glass Driver with Embedded MCU and LIN for High End Mirror											
MM908E624	Triple High Side Switch with Embedded MCU+Power+LIN											
MM908E625	Quad Half H-Bridge with P/S + HC08 + LIN											
MM912_634	Integrated S12 MagniV Based Relay Drivers with LIN											
MM912_634	Integrated S12 MagniV Based Relay Drivers with LIN	See S12 MagniV Mixed-Signal MCUs (page 11)										
MC12XS2	G12 V Multipurpose Low $R_{DS(on)}$ eXtreme Switches											
MC33981	Single High Side Switch (4.0 m Ω), with PWM, Protection and Diagnostics	1	H	40	4	100	5.0	Parallel	Status Pin, Current Monitor, Temperature	Over-current, Over-temperature, Short-circuit, Under-voltage Lock Out	16-pin PQFN	Production EVB
MC33982	Self Protected 2.0 m Ω Switch with Diagnostic and Protection	1	H	60	2	150	5.0	SPI and Parallel	SPI	Temp Sense, Over/Under-voltage, Shutdown, Over-current, Reverse Polarity, Current Recopy	16-pin PQFN	Production EVB
MC33984	Self Protected 4.0 m Ω Switch with Diagnostic and Protection	2	H	30	4	100	5.0	SPI and Parallel	SPI	Temp Sense, Over/Under-voltage, Shutdown, Over-current, Reverse Polarity, Current Recopy	16-pin PQFN	Production EVB
MC33988	Self Protected 8.0 m Ω Switch with Diagnostic and Protection	2	H	30	8	60	5.0	SPI and Parallel	SPI	Temp Sense, Over/Under-voltage, Shutdown, Over-current, Reverse Polarity, Current Recopy	16-pin PQFN	Production EVB
MC12XS3	12V Automotive Exterior Lighting Multichannel eXtreme Switches											
MC06XS3517	Penta High Side Switch (3 x 6m Ω , 2 x 17 m Ω), with PWM, Protection, Diagnostics and SPI Control. Also, 1 logic level output driver.	5+1	H	2.8, 5.5	3 X 6, 2 X 17	48, 96	5.0	SPI and Parallel	SPI	Over-current, Over-temperature, Over-voltage, Under-voltage & Short-circuit protect	24-pin PQFN	Production EVB
MC07XS3200	Dual High Side Switch (2 x 7m Ω), with PWM, Protection, Diagnostics and SPI Control	2	H	6.0	2 X 7	93	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	32-pin SOICW Exposed Pad	Production EVB
MC09XS3400	Quad High Side Switch (4 x 9m Ω), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	4 X 9	89	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC10XS3412	Quad High Side Switch (2 x 10 m Ω , 2 x 12 m Ω), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	2 x 10, 2 x 12	78	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC10XS3425	Quad High Side Switch (2 x 10 m Ω , 2 x 25m Ω), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	2 X 10, 2 X 25	39, 78	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	32-pin SOICW Exposed Pad	Production EVB
MC10XS3435	Quad High Side Switch (2 x 12 m Ω , 2 x 35 m Ω), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	2 x 10, 2 x 35	78	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB

ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Power Actuation — High-Side Switches (Solid State Intelligent Switches) (continued)

Product	Description	No of Outputs	High-Side or Low-Side	Maximum Current Each Output (A)	R _{DS(on)} (mΩ) of Each Output	Current Limitation (A)	Current Limitation Standby Max (μA)	Control ¹	Status/Fault Reporting	Protection Features	Packaging	Status
MC10XS3535	Penta High Side Switch (3 x 10 mΩ, 2 x 35 mΩ), with PWM, Protection, Diagnostics and SPI Control. Also, 1 logic level output driver.	5+1	H	2.8, 5.5	3x10, 2x35	44, 88	2.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC15XS3400	Quad High Side Switch (4 x 15 mΩ), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	15	78	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC35XS3400	Quad High Side Switch (4 x 35 mΩ), with PWM, Protection, Diagnostics and SPI Control	4	H	6.0	35	39	5.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC35XS3500	Penta High Side Switch (5 x 35 mΩ), with PWM, Protection, Diagnostics and SPI Control. Also, 1 logic level output driver.	5+1	H	2.8	35	39.5	2.0	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	24-pin PQFN	Production EVB
MC12XS6	External Automotive Lighting Multichannel Scalable eXtreme Switches											
MC07XS6517	Penta High Side Switch (3 x 7 mΩ, 2x 17 mΩ), with PWM, Protection, Diagnostics and SPI Control. Also, 1 logic level output driver.	5+1	H	11, 5.5	3 x 17 2 x 7	100, 50	20	SPI Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	54-pin SOICW Exposed PAD	Production EVB
MC17XS6500	Penta High Side Switch (5 x 17 mΩ), with PWM, Protection, Diagnostics and SPI Control. Also, 1 logic level output driver.	5+1	H	5.5	5 x 17	50	20	SPI Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit	32-pin SOICW Exposed PAD	Production EVB
MC24XS4	External Automotive Lighting Multichannel Scalable eXtreme Switches											
MC06XS4200	Dual High Side Switch (2 x 6mΩ), with PWM, Protection, Diagnostics and SPI Control (24V)	2	H	9.0	2 X 6	30, 90	10	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit, Parallel operation	24-pin PQFN	Production EVB
MC10XS4200	Dual High Side Switch (2 x 10mΩ), with PWM, Protection, Diagnostics and SPI Control (24V)	2	H	6.0	2 X 10	18, 55	10	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit, Parallel operation	24-pin PQFN	Production EVB
MC20XS4200	Dual High Side Switch (2 x 20mΩ), with PWM, Protection, Diagnostics and SPI Control (24V)	2	H	3.0	2 X 20	9.0, 27	10	SPI and Parallel	SPI	Fail Safe Mode, Over-current Shutdown, Over-temperature, Short-circuit, Parallel operation	24-pin PQFN	Production EVB

1. Products available with SPI Control work with the KITUSBSPIEVM and the KITUSBSPIDGLVME USB-SPI Interface Boards.

Power Actuation — H-Bridges and Motor Drivers

Product	Description	Main Characteristics	No of Outputs	R _{DS(on)} (mΩ) of Each Output	Current Limitation (A)	Current Limitation Standby Max	Control ¹	Status/Fault Reporting	Protection Features	Packaging	Status
MC33186	H-Bridge Driver (5.0 A)	40 V/150 mΩ per FET	2	150	6.5	20 mA	Parallel	1 Status Pin	Short Circuit, Current Limit, Temp Sense	20-pin HSOP	Production
MC33879	(1.0 Ω R _{DS(on)}) Configurable Eight Output SPI Controlled Switch	(1.0 Ω R _{DS(ON)}) Configurable Eight Output SPI Controlled Switch	8	550	1.2	25 μA	SPI w/2 PWM	SPI	Short Circuit, Current Limit, Temp Sense	32-pin SOICW Exposed Pad	Production EVB
MC33880	Configurable Eight Output SPI Controlled Switch	(1.0 Ω R _{DS(ON)}) Configurable Eight Output SPI Controlled Switch	8	550	1.2	25 μA	SPI w/2 PWM	SPI	Short Circuit, Current Limit, Temp Sense	32-pin SOICW	Production EVB
MC33886	H-Bridge Driver (5.2 A)	225 mΩ @ 150°C	2	120	6.0	20 mA	Parallel	1 Status Pin (Overcurrent / Overtemp)	Short Circuit, Current Limit, Temp Sense	20-pin HSOP	Production EVB
MC33887	H-Bridge Driver with Sleep Mode (5.2 A)	130 mΩ @ 25°C, sleep mode, current sense	2	130	6.0	25 μA	Parallel	1 Status Pin (Overcurrent / Overtemp)	Short Circuit, Current Limit, Temp Sense	20-pin HSOP, 36-pin PQFN, 54-pin SOICW Exposed Pad	Production EVB

Power Actuation — H-Bridges and Motor Drivers (continued)

Product	Description	Main Characteristics	No of Outputs	$R_{DS(on)}$ (m Ω) of Each Output	Current Limitation (A)	Current Limitation Standby Max	Control ¹	Status/Fault Reporting	Protection Features	Packaging	Status
MC33899	Programmable H-Bridge Power IC	Designed to drive a DC motor in both forward and reverse shaft rotation under Pulse Width Modulation (PWM) of speed and torque.	2	100	11.5	50 μ A	SPI and Parallel	SPI	Open Circuit detect, Undervoltage, Overtemperature Shutdown, Output Short Circuit Current Limit	30-pin HSOP	Production
MC33926	5.0 A Throttle Control H-Bridge	H-Bridge power IC for DC servo motor control like engine throttle control. Load can be PWM'ed up to 20 kHz.	2	120	8.0	50 μ A	Parallel	Status Flag	Output Short Circuit Protect, Overcurrent Limit, Overtemperature	32-pin PQFN	Production EVB
MC33931	5.0 A Throttle Control H-Bridge	H-Bridge power IC for DC servo motor control like engine throttle control. Load can be PWM'ed up to 11 kHz	2	120	8.0	50 μ A	Parallel	Status Flag	Output Short Circuit Protect, Overcurrent Limit, Overtemperature	44-pin HSOP, 32-pin SOICW with Exposed Pad	Production EVB
MC33932	5.0 A Throttle Control Dual H-Bridge	H-Bridge power IC for DC servo motor control like engine throttle control. Load can be PWM'ed up to 11 kHz	4	120	8.0	50 μ A	Parallel	Status Flag	Output Short Circuit Protect, Overcurrent Limit, Overtemperature	44-pin HSOP, 54-pin SOICW with Exposed Pad	Production EVB

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boards.

Power Actuation — H-Bridge Stepper Motors

Product	Description	Main Characteristics	Operating Voltage (V)	Packaging	Status
MM908E626	Stepper Motor Control, Quad Half-Bridge with Embedded MCU and LIN for High Temperature $T_J = 135^\circ\text{C}$	Voltage Regulator 5.0 V/60 mA, LIN Physical Layer with Selectable Slewrates	5 to 28	54-pin SOICW Exposed Pad	Production EVB ('625)

Power Actuation — Pre-Drivers (High-Side MOSFET Gate Drivers)

Product	Description	Main Characteristics	Operating Voltage (V)	Control ¹	Output Drives High/Low-Side, Drive Current	Status Reporting	Protection Features	Packaging	Status
MC33800	Engine Control Integrated Circuit	Engine control IC, with six MOSFET gate pre-drivers, eight Low-Side Switches, and two constant current Low-Side Switches	5.0 to 36	Parallel, SPI	6 H, 2 mA (typ)	SPI	Open Load detect, Overcurrent, Overvoltage, Shorted Load detect, Undervoltage, Thermal	54-pin SOICW Exposed Pad	Production EVB
MC33810	Automotive Engine Control IC	Engine control IC with four MOSFET/IGBT gate drivers and four Low-Side switches.	4.5 to 36	Parallel, SPI	4 L, 780 μ A (typ)	SPI, Status Flags	Shorted Load detect, Thermal	32-pin SOICW Exposed Pad	Production EVB
MC33812	Single cylinder Engine control IC.	Engine control power IC, with 3 Low-Side drivers, one pre-driver, +5V pre-regulator, ISO-9141 physical interface and MCU watchdog circuit.	4.5 to 36	Parallel	2L, 4.0 A (typ) 1L, 1.5 A (typ)	Parallel	Overcurrent, Outputs Short to Battery, Overtemperature Protect	32-pin SOICW Exposed Pad	Production EVB Ref.Dsgn.
MC33883	Quad TMOS driver, for fuel injector	Quad TMOS driver, in H-Bridge configuration	5.5 to 28/55	4 non-invert CMOS, LSTTL logic	n/a	None	Overvoltage, Undervoltage	20-pinSOICW	Production EVB
MC33937	Three-Phase Field Effect Transistor Pre-Driver	Triple High-Side and Low-Side FET pre-drivers, with parallel & SPI control and programmable deadtime (shoot-through protect).	8.0 to 58	Parallel, SPI	3 H, 3 L, 1.0 A (typ)	SPI	Programmable Deadtime, Reverse Charge Injection	54-pin SOICW Exposed Pad	Production EVB

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boar

Product	Description	Main Characteristics	Regulation Voltage	Operating Voltage (V)	Packaging	Status
MC33797	Four Channel Squib Driver IC	Four-Channel High-Side and Low-Side 2.0 A FET Switches, Externally Adjustable FET Current Limiting, Adjustable Current Limit Range: 0.8 A to 2.0 A, 8-Bit SPI for Diagnostics and FET Switch Activation, Diagnostics for High-Side Safing Sensor Status	7.0 to 35	4.75 to 5.25	32-pin SOICW	Production



ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Power Actuation — Powertrain Control and Engine Management

Product	Description	Main Characteristics	Peak Current Limit (A)	R _{DS(on)} (mΩ)	Control ¹	Operating Voltage (V)	Packaging	Status
MC33800	Engine Control Integrated Circuit	Engine control IC, with six MOSFET gate pre-drivers, eight Low-Side Switches, and two constant current Low-Side Switches.	2 @ 6.0 6 @ 2.0 1 @ 2.8 1 @ 1.0	2 @ 700 6 @ 1000 1 @ 250 1 @ 1000	SPI, Parallel	5.0 to 36	54-pin SOICW Exposed Pad	Production EVB
MC33810	Automotive Engine Control IC	Engine control IC with four MOSFET/IGBT gate drivers and four Low-Side Switches.	6.0	100	SPI, Parallel	4.5 to 36	32-pin SOICW Exposed Pad	Production EVB
MC33811	Solenoid Monitor Integrated Circuit See Signal Conditioning (page 7)	5 input solenoid monitoring to verify proper electrical and mechanical solenoid operation.	—	—	SPI	10.5 to 15.5	16-pin SOICW	Production EVB
MC33812	Single cylinder Engine control IC	Engine control power IC, with 3 Low-Side drivers, one pre-driver, +5V pre-regulator, ISO-9141 physical interface and MCU watchdog circuit.	2 @ 6.0 1 @ 2.0	2@200 1@1000	Parallel	4.5 to 36	32-pin SOICW Exposed Pad	Production EVB Ref.Dsgn.
MC33813	One Cylinder Small Engine Control IC	Engine control analog power IC intended for one cylinder motorcycle and other small engine control applications. Includes ISO9141 coomunication interface.	1 @ 3.0 1 @ 6.0 2 @ 2.4 1 @ .110	1 @ 400 1 @ 300 2 @ 1500 1 @ 20000	SPI, Parallel	6.0 to 18	48-pin LFQP, Exposed Pad	Production EVB
MC33814	Two Cylinder Small Engine Control IC	Engine control analog power IC intended for two cylinder motorcycle and other small engine control applications. Includes ISO9141 coomunication interface.	2 @ 3.0 1 @ 6.0 2 @ 2.4 1 @ .110	2 @ 400 1 @ 300 2 @ 1500 1 @ 20000	SPI, Parallel	6.0 to 18	48-pin LFQP, Exposed Pad	Production EVB
MC33816	Engine Control IC with Smart Gate Control	A 12-channel gate driver IC for automotive engine control applications. The IC consist of five external MOSFET high side pre-drivers and seven external MOSFET low side pre-drivers. Also contains four independent and concurrent digital microcores	-	-	SPI Parallel	9.0 to 16	64-pin LQFP Exposed Pad	Jan. 2014 EVB
MC33899	Programmable H-Bridge Power IC	Designed to drive a DC motor in both forward and reverse shaft rotation under pulse-width modulation (PWM) of speed and torque. Can be controlled by SPI or parallel control lines.	15.0	90	SPI, Parallel	6.0 to 26.5	30-pin HSOP	Production
MC33926	5.0 A Throttle Control H-Bridge	H-Bridge power IC for DC servo motor control like engine throttle control. Load can be PWM'ed up to 20 KHz	8.0	120	Parallel	8.0 to 28	32-pin PQFN	Production EVB
MC33937	Three-Phase Field Effect Transistor Pre-Driver	Triple High-Side and Low-Side FET pre-drivers, with parallel & SPI control and programmable deadtime (shoot-through protect).	—	—	SPI, Parallel	8.0 to 58	54-pin SOICW Exposed Pad	Production EVB
MC33975	22 input Multiple Switch Detect Interface with 32 mA Wetting Current and Wake-up See Signal Conditioning (page 8)	22 inputs contact monitoring (14 GND, 8 configurable), 4.0 mA or 32 mA pulse wetting current, low-power mode interrupt capability, wake-up. Can supply current to external sensors.	—	—	SPI	5.5 to 26.5	32-pin SOICW Exposed Pad	Production EVB

1. Products available with SPI Control work with the KITUSBSP1EVME and the KITUSBSP1DGLVME USB-SPI Interface Boards.



ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Communication Transceivers — CAN Physical Interface Components

Product	Description	Main Characteristics	Bus Type and Standard	Operating Voltage (V)	Current Limitation (μA)	Standby Max	Other Features	Control and Status Reporting ¹	Protection Features	Packaging	Status
MC33742	System Basis Chip with Enhanced High-Speed CAN (250k to 1Mbps)	See System Basis Chip (page 10)									
MC33889	System Basis Chip Lite with Low-Speed CAN										
MC33897	Single-wire CAN	Low or high (33.3 kbps or 83.3) kbps data rates, wake-up capability (GMW3089 v2.3 compatible)	Single-wire CAN	6.0 to 27	45	60	Regulator Control Output Waveshaping, Undervoltage lockout detect and loss of GND	2 Mode Control Pins	Thermal shutdown, current limit	14-pin SOICN	Production
MC33989	System Basis Chip with High-Speed CAN	See System Basis Chip (page 9)									
MC33901	High-Speed CAN Transceiver										
MC33903	System Basis Chip(SBC)-Gen 2-with High Speed CAN & LIN Interfaces	See System Basis Chip (page 10)									
MC33904	System Basis Chip (SBC)-Gen 2-with High Speed CAN Interface										
MC33905	System Basis Chip (SBC)-Gen 2-with High Speed CAN & LIN Interfaces										
MC33907	Safe System Basis Chip with Buck and Boost DC/DC up to 800 mA										
MC33908	Safe System Basis Chip with Buck and Boost DC/DC up to 1.5 A										
MC33909	System Basis Chip with CAN, LIN and Multiple Switch-to-Ground Interface										

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLVME USB-SPI Interface Boards.

ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Communication Transceivers — LIN, ISO-9141, J-1850 Physical Interface Components

Product	Description	Main Characteristics	Bus Type and Standard	Operating Voltage (V)	Current Limitation Standby (µA)		Other Features	Control and Status Reporting ¹	Protection Features	Packaging	Status
					Typ	Max					
MC33399	Local Interconnect Network (LIN) Physical Layer	Offers speed communication from 1.0 kbps to 20 kbps, and up to 60 kbps for Programming Mode. It supports LIN Protocol Specification 1.3.	LIN Single-wire	7.0 to 18	20	50	Wake-up input pin, control of external voltage regulator	Parallel	Current limitation, Thermal protection	8-pin SOICN	Production EVB
MC33660	ISO K Line Serial Link Interface	ISO9141 physical interface device	ISO9141	8.0 to 18	—	50	Data rates up to 50 Kbps	Serial	Output short circuit Thermal protection	8-pin SOICN	Production EVB
MC33661	eLIN – Enhanced LIN Physical Layer (Local Interconnect Network)	Selectable slew rate for operations at 10, 20, 100 kbps; bus short to ground fail safe; excellent EMC behavior.	LIN Single-wire	7.0 to 18	8.0	12	Compatibility with 5.0 V and 3.3 V micros, wake-up input control of external regulator	Parallel	Current limitation, Thermal protection	8-pin SOICN	Production EVB
MC33662	LIN 2.1/SAE J2602-2 LIN Physical Layer Transceiver	Single wire LIN supports normal baud rates of 10 kbps (J) or 20 kbps (L) and fast rate of 100 kbps	LIN single wire, SAE J2602-2	7.0 to 18	6.0	11	Active bus waveshaping, EMI immunity, Local & Remote wakeup	Parallel	Current limitation, Thermal protection	8-pin SOICN	Production EVB
MC33663	LIN 2.1 / SAEJ2602-2 Dual LIN Physical Layer Transceivers	Integrates two physical layer LIN bus transceivers. The devices offer baud rates of 10 and 20 kbps as well as 100 kbps for test/programming modes.	LIN Single-wire, SAE J2602-2	7.0 to 18	12	36	Active bus waveshaping, EMI immunity, 2 wake-up input pins, Compatibility with 5.0 V and 3.3 V micros	Parallel	Over-temperature protection, Output short circuit	14-pin SOICN	Production
MC33812	Single cylinder Engine control IC	Engine control power IC, with 3 Low-Side drivers, one pre-driver, +5V pre-regulator, ISO-9141 physical interface and MCU watchdog circuit.	ISO-9141	4.5 to 36	—	—	MCU watchdog timer, +5V pre-regulator for MCU, MCU power on RESET	Parallel	Overcurrent Outputs Short to Battery, Overtemperature Protect	32-pin SOICW	Production EVB Ref.Dsgn.
MC33903	System Basis Chip(SBC)-Gen 2-with High Speed CAN & LIN Interfaces	See System Basis Chip (page 10)									
MC33905	System Basis Chip (SBC)-Gen 2-with High Speed CAN & LIN Interfaces										
MC33907	Safe System Basis Chip with Buck and Boost DC/DC up to 800 mA										
MC33908	Safe System Basis Chip with Buck and Boost DC/DC up to 1.5 A										
MC33909	System Basis Chip with LIN, CAN and Multiple Switch-to-Ground Interface										
MC33910	System Basis Chip with High-Side Drivers and LIN Physical Interface										
MC33911	System Basis Chip with DC Motor Pre-driver and LIN Physical Interface										
MC33912	System Basis Chip with DC Motor Pre-driver and Current Sense and LIN Physical Interface										

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boards.



AND MIXED-SIGNAL PRODUCTS (continued)

Communication Transceiver - Distributed Systems Interface (DSI) Components

Product	Description	Main Characteristics	Max Data Rate	Operating Temp Range (°C)	Bus Sw. Resistance, typ/max (Ω)	Packaging	Status
MC33780	Dual DSI Master with Differential Drive	Bus controller for two differential DSI channels. SPI port for uC interface. Variable CRC generation and detection, thermal protection, frequency spreading.	150 kbps	-40 to +85	n/a	16-pin SOICW	Production
MC33781	Quad DSI Master with Differential Drive	Bus controller for four differential DSI channels. Dual SPI ports for uC and safing interfaces. Variable CRC generation and detection, comprehensive fault detection, thermal protection, frequency spreading	200 kbps	-40 to +90	n/an/a	32-pin SOICW Exposed Pad	Production
MC33784	DSI Sensor Interface	DSI slave device optimized as a sensor interface. Differential bus capability & dual bus switches for improved EMC performance, 2-channel 10-bit ADC, 5.0V regulated output, 3 configurable logic pins, CRC generation and checking.	n/a	-40 to +150	3.0/6.0	16-pin SOICN	Production
MC33789	Airbag System Basis Chip (IC) (SBC)	Air bag control module which monitors battery voltage, sensor status and supplies various voltages to the air bag system. Uses SPI for MCU communication. Uses PSI5 for satellite sensors communication.	125 kbps	-40 to +125	n/a	64-pin LQFP Exposed Pad	Production EVB (contact sales)
MC33790	Distributed System Interface (DSI) Physical Interface (DSIP)	Dual current-limited waveshaped outputs, current sensing inputs, 3.3 V and 5.0 V	5 - 150 kbps	-40 to +85	6.0	16-pin SOICW	Production
MC33793	DSI Sensor Interface	DSI slave device. 5.0 V regulated output, 4 configurable I/O pins (logic I/O or 8-bit ADC), fault tolerant, logic output high current buffer.	n/a	-40 to +125	4.0/8.0	16-pin SOICN	Production

Signal Conditioning

Product	Description	Main Characteristics	Switch Monitor Voltage (V)	Operating Voltage (V)	Packaging	Status
MC33811	Solenoid Monitor Integrated Circuit	5 input solenoid monitoring to verify proper electrical and mechanical solenoid operation.	0 to 64	10.5 to 15.5	16-pin SOICW	Production EVB
MC33972	22 input Multiple Switch Detect Interface with 16 mA Wetting Current and Suppressed Wake-up	Multiple switch detection interface with suppressed wake-up designed to detect closing and opening of up to 22 switch contacts (14 GND, 8 configurable), wetting current of 2.0 mA or 16 mA.	-14 to 38 -14 to 40	5.5 to 26	32-pin SOICW, 32-pin SOICW Exposed Pad	Production EVB
MC33975	22 input Multiple Switch Detect Interface with 32 mA Wetting Current and Wake-up	22 inputs contact monitoring (14 GND, 8 configurable), 4.0 mA or 32 mA pulse wetting current, low-power mode interrupt capability, wake-up. Can supply current to external sensors.	-14 to 38/40	5.5 to 26.5	32-pin SOICW Exposed Pad	Production EVB



ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

System Basis Chip

Product	Description	Main Characteristics	Bus Type and Standard	Operating Voltage (V)	Current Limitation Standby (µA)		Other Features	Control and Status Reporting ¹	Protection Features	Packaging	Status
					Typ	Max					
MC33742	System Basis Chip with Enhanced High-Speed CAN (250K to 1Mbps)	SBC, Dual V _{REG} . Enhance HS CAN with Bus failure diagnostic capability, 4 wake-up inputs.	CAN High-Speed dual wires	5.5 to 27	60	150	Low power modes, remote and local wake-up capabilities	SPI	Current and thermal protection for CAN and regulator	28-pin SOICW, 48-pin QFN	Production EVB
MC33789	Airbag System Basis Chip (SBC) with Power Supply and PSI5 Sensor Interface	Air bag control module which monitors battery voltage, sensor status and supplies various voltages to the air bag system. Uses SPI for MCU communication. Uses PSI5 for satellite sensors communication.	PSI5	5.2 to 20	-	-	Safing state machine, 9 switch input monitors, 2 config. high/low side drivers, Power-on-reset, watchdog timer, Squib energy reserve	SPI	Safing state machine, Scrap mode	64-pin LQFP Exposed Pad	Production EVB (contact sales)
MC33889	System Basis Chip with Low-Speed Fault Tolerant CAN	Dual 5.0 V regulators LS CAN, 2 wake-up inputs	CAN Low-Speed, dual wires	5.5 to 27	60	100	Dual voltage regulator, Watchdog, wake-up input, sleep and stop modes	SPI	Fault tolerant	28-pin SOICW	Production EVB
MC33903	System Basis Chip(SBC)-Gen 2-with High Speed CAN & LIN Interfaces	High speed CAN and 1 or 2 LIN physical interface. 5.0 or 3.3 V VDD regulator.	CAN high-speed, dual wires, LIN single wire	5.5 to 27	15	35	Fail-safe state machine, Configurable I/O, MUX - out, pin compatible with MC33905	"Secured" SPI	Overcurrent, Overtemperature, Short circuit, protec	32-pin SOICW Exposed Pad	Production EVB
MC33904	System Basis Chip (SBC)-Gen 2-with High Speed CAN Interface	High speed CAN physical interface. 5.0 or 3.3 VDD and VAux regulators, w/current sharing	CAN high-speed, dual wires	5.5 to 27	15	35	Fail-safe state machine, Configurable I/O, MUX - out, pin compatible with MC33905	"Secured" SPI	Overcurrent, Overtemperature, Short circuit and undervoltage detect	32-pin SOICW Exposed Pad	Production EVB('905)
MC33905	System Basis Chip (SBC)-Gen 2-with High Speed CAN & LIN Interfaces	High speed CAN & 1 or 2 LIN physical interfaces. 5.0 or 3.3 VDD and VAux regulators, w/current sharing.	CAN high-speed, dual wires. LIN single wire	5.5 to 27	15	35	Fail-safe state machine, Configurable I/O, MUX - out, SAFE output, Low power modes w/INT and RST capability.	"Secured" SPI	Overcurrent, Overtemperature, Short circuit and undervoltage detect	32-pin SOICW Exposed Pad, 54-pin SOICW Exposed Pad	Production EVB
MC33907	Safe System Basis Chip with Buck and Boost DC/DC up to 800 mA	Multiple switching and linear voltage regulators, built-in enhanced high speed CAN interface fulfills the ISO11898-2 and -5 standards.	CAN high-speed, dual wires.	5.6 to 40	32	60	Safe Assure product	"Secured" SPI	Over-current, Over-temperature, Over & Under-voltage detect	48-pin LQFP Exposed Pad	Feb. 2014
MC33908	Safe System Basis Chip with Buck and Boost DC/DC up to 1.5 A	Multiple switching and linear voltage regulators, built-in enhanced high speed CAN interface fulfills the ISO11898-2 and -5 standards.	CAN high-speed, dual wires.	5.6 to 40	32	60	Safe Assure product	"Secured" SPI	Over-current, Over-temperature, Over & Under-voltage detect	48-pin LQFP Exposed Pad	Feb. 2014
MC33909	System Basis Chip with CAN, LIN Multiple Switch-to-Ground Interface	Two high speed CAN interfaces plus four LINs, compatible with specification 2.1 and SAEJ2602-2. Also contains 17 switch to ground inputs for switch detection.	CAN high-speed, dual wires. LIN single wire	3.5 to 27	125	-	Watchdog timer, Switched inputs wake-up, Fail safe mode	SPI	Over Voltage	64-pin LQFP Exposed Pad	3Q2013
MC33910	System Basis Chip with High-Side Drivers and LIN Physical Interface	LIN 2.0 compatible, 5.0 V/60 mA LDO, 2 High-Side drivers w/PWM, 1 analog/digital input	LIN Single-wire	5.5 to 18	48	80	Hall Sensor supply, Configurable Window Watchdog	SPI	Multiple wake-up sources, LDO Fault Detect, Low Voltage Reset	32-pin LQFP	Production EVB ('912)
MC33911	System Basis Chip with DC Motor Pre-driver and LIN Physical Interface	LIN 2.0 compatible, 5.0 V/60 mA LDO, 1 High-Side driver & 2 Low-Side drivers w/PWM, 2 analog/digital inputs	LIN Single-wire	5.5 to 18	48	80	Configurable Window Watchdog	SPI	Multiple wake-up sources, LDO Fault Detect, Low Voltage Reset	32-pin LQFP	Production EVB ('912)
MC33912	System Basis Chip with DC Motor Pre-driver and Current Sense and LIN Physical Interface.	LIN 2.0 compatible, 5.0 V/60 mA LDO, 2 High-Side drives & 2 Low-Side drivers w/PWM, 4 analog/digital inputs	LIN Single-wire	5.5 to 18	48	80	Hall Sensor supply, Configurable Window Watchdog, Current Sense	SPI	Multiple wake-up sources, LDO Fault Detect, Low Voltage Reset	32-pin LQFP	Production EVB
MC33989	System Basis Chip with High-Speed CAN	Dual 5.0 V regulators HS CAN, 4 wake-up inputs	CAN High-Speed, dual wires	5.5 to 27	80	150	Dual voltage regulator, Watchdog, wake-up input, sleep and stop modes	SPI	Current limitation, thermal	28-pin SOICW	Production EVB

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boards

ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Embedded MCU + Power

Product	Description	Main Characteristics	MCU Reference	MCU Detail	Additional Information	Packaging	Status
MM912_637	Xtrinsic Battery Sensor with LIN for 12V Lead-acid Batteries	Simultaneous Battery voltage & current measurement with 16-bit sigma-delta ADC & IIR filter. Voltage Regulators: 2.5 V/10mA & 60mA, 5.0 V/80 mA. LIN 2.1 Physical Layer w/Selectable Slew rates and triggered wake-up,	16-Bit MCU CPU12_V1	S12 16-Bit core, 128K/96K Bytes Flash, 6K Bytes RAM, 4K bytes data Flash, ESCI, 16-bit 4 Channel Timer, Internal Clock Generator, BDM	Selectable Internal or external temp sense, GPIO, including SPI functionality, internal or external oscillator. Window Watchdog with Selectable Timing, Normal/Stop/Sleep/Crank Mode Ctrl. High Voltage Wake-up Inputs,	48-pin QFN, Exposed Pad	Production EVB

ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Embedded MCU + Power

Product	Description	Main Characteristics	MCU Reference	MCU Detail	Additional Information	Packaging	Status
MM9Z1_638	Xtrinsic Battery Sensor with CAN and LIN	This is a fully integrated battery monitoring device. The device supports precise current measurement via an external shunt resistor. The MM9Z1_638 includes LIN 2.2 protocol and physical interface, and an MSCAN protocol controller.	16-Bit MCU S12Z	S12Z MCU with 128 KB Flash, 8 KB RAM, 4 KB EEPROM	Four battery voltage measurements with internal resistor dividers, and up to five direct voltage measurements for use with an external resistor divider. Measurement synchronization between voltage channels and current channels.	48-pin QFN Exposed Pad	1Q 2014 (EVB- In Dsgn.)
MM912_P812	S12P MCU and Multifunctional Ignition and Injector Driver System In Package (SiP)	An engine control IC combining an MCU (S12P) and analog control die (MC33812) intended for motorcycle and other single/dual cylinder small engine control applications.	16-Bit MCU S12P	The MCU S12P has 6 KB RAM, and flash memory size of 96 KB or 128 KB. The S12P family uses many of the same features found on the S12XS family, including error correction code (ECC) on flash memory, a separate data-flash module for diagnostic or data storage, a fast analog-to-digital converter (ATD), and a frequency modulated phase locked loop (IPLL) that improves electromagnetic compatibility (EMC).	Analog functions consists of three integrated low side drivers, one pre-driver, a +5.0 V, voltage pre-regulator, an MCU watchdog circuit, an ISO 9141 K-Line interface, and a parallel interface for MCU communication. The three low side drivers are provided for driving a fuel injector, a lamp or LED, and a relay, another injector or fuel pump.	100 lead LQFP, Exposed Pad	Production Ref.Dsgn.
MM912_S812	S12XS MCU and Multifunctional Ignition and Injector Driver System In Package (SiP)	An engine control IC combining an MCU (S12XS) and analog control die (MC33812) intended for motorcycle and other single/dual cylinder small engine control applications.	16-Bit MCU S12XS	The MCU S12XS has 8 KB or 12 KB RAM, and flash memory size of 128 KB or 256 KB. The S12XS family uses many of the same features found on the S12P family, including error correction code (ECC) on flash memory, a separate data-flash module for diagnostic or data storage, a fast analog-to-digital converter (ATD), and a frequency modulated phase locked loop (IPLL) that improves the electromagnetic compatibility (EMC) performance.	Analog functions consists of three integrated low side drivers, one pre-driver, a +5.0 V, voltage pre-regulator, an MCU watchdog circuit, an ISO 9141 K-Line interface, and a parallel interface for MCU communication. The three low side drivers are provided for driving a fuel injector, a lamp or LED, and a relay, another injector or fuel pump.	100 lead LQFP, Exposed Pad	Production Ref. Dsgn.

S12 MagniV Mixed-signal MCUs

Product	Description	Main Characteristics	Power Features	MCU Reference	MCU Detail	Additional Information	Packaging	Status
MM912_634	Integrated S12 MagniV Based Relay Drivers with LIN	Cascaded dual Voltage Regulator 2.5 V/50 mA and 5.0 V/80 mA, LIN Physical Layer with Selectable Slew rates, Window Watchdog with SelectableDual High-Side and Dual Low Side Switches with Embedded S12 MCU + Power + LIN	7 Ω High-Side Switches, 2.5 Ω Low-Side Switches for relay drivel	16-Bit MCU	S12 16-Bit Core, 32KB Flash, 2KB RAM, ESCI, Multi channel 10-bit ADC, 16-bit 4 Channel Timer, Internal Clock Generator	High Voltage Wake-up Inputs, Selectable Gain I-Sense, Battery Voltage Sense. Timing, Normal/ Stop/Sleep Mode Control, Hall Supply of 18 V/30 mA	48-pin LQFP Exposed Pad	Production EVB
S12V MagniV MCU Products	See Page 26 for S12V MagniV MCUs information							

ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

8-bit Intelligent Distributed Controllers

Product	Description	Main Characteristics	Power Features	MCU Reference	MCU Detail	Additional Information	Packaging	Status
MM908E621	DC Motor/Mirror Control and LIN Mirror Control, Integrated Quad Half-Bridge and Triple High-Side with Embedded MCU and LIN	Voltage Regulator 5.0 V/60 mA, LIN Physical Layer with Selectable Slew rates, Window Watchdog, "Normal/Stop/Sleep Mode "Control	2 x 275 m Ω Half-Bridges; 2 x 750 m Ω Half-Bridges; 1 x 185 m Ω High-Side; 2 x 440 m Ω High-Side; Switched 5.0 V Output (25 mA)	8-Bit MCU MC68HC908EY16	HC08 Core, 16K Flash, 512 Bytes RAM, ESCI, 8-Channel 10-bit ADC, Two 16-bit 2 Channel Timers, Internal Clock Generator	2/3 Pin Hall Sensor Input, Analog Input with Current Source, 40 V Rated Wake-up Input, V _{sup} , Chip Temp. and Current Sensing	54-pin SOICW Exposed Pad	Production
MM908E622	DC Motor/Mirror Control and LIN Mirror Control, Integrated Quad Half-Bridge, Triple High-Side and EC Glass Driver with Embedded MCU and LIN	Voltage Regulator 5.0 V/60 mA, LIN Physical Layer with Selectable Slew rates, Window Watchdog, "Normal/Stop/Sleep Mode "Control	2 x 275 m Ω Half-Bridges; 2 x 750 m Ω Half-Bridges; 1 x 185 m Ω High-Side; 2 x 440 m Ω High-Side; Switched 5.0 V Output (25 mA) EC Glass Driver			2/3 Pin Hall Sensor Input, Analog Input with Current Source, 40 V Rated Wake-up Input, V _{sup} , Chip Temp. and Current Sensing	54-pin SOICW Exposed Pad	Production
MM908E624	DC Motor Control Using Relays (for example, Window Lift, Sun Roof, and Power Seats), Triple High-Side Switch with Embedded MCU + Power + LIN	Voltage Regulator 5.0 V/50 mA, LIN Physical Layer with Selectable Slew rates, Window Watchdog with Selectable Timing, Normal/Stop/Sleep Mode Control	1 x 7 Ω High-Side, 2 x 2.5 Ω High-Side Switches for Relay Control			Operational Amplifier, 2 x 40 V Rated Wake-up Inputs	54-pin SOICW	Production EVB
MM908E625	Mirror Control, Stepper Motor Control, Door Lock Quad Half-Bridge and Single High-Side with Embedded MCU and LIN	Voltage Regulator 5.0 V/60 mA, LIN Physical Layer with Selectable Slew rates, Timeout Watchdog with Periodic Wake-up Feature, Normal/Stop Modes	4 x 400 m Ω Half-Bridges with Current Control; 1 x 600 m Ω High-Side; Switched 5.0 V Output (25 mA)			3 x 2 Pin Hall Sensor Inputs with Cyclic Wake-up Feature, Analog Input with Current Source, V _{sup} , Chip Temp. and Current Sensing	54-pin SOICW Exposed Pad	Production EVB
MM908E626	Stepper Motor Control, Quad Half-Bridge with Embedded MCU and LIN	Voltage Regulator 5.0 V/60 mA, LIN Physical Layer with Selectable Slew rates. High Temperature use, T _J = 135 \times C	4 x 400 m Ω Half-Bridges with Current Control; Switched 5.0 V Output (24 mA)			V _{sup} , Chip Temperature and Current Sensing	54-pin SOICW Exposed Pad	Production EVB ('625)



FREESCALE SEMICONDUCTOR POWER MANAGEMENT PRODUCTS

The Power Management products portfolio provides solutions for Linear and Switching voltage regulators. Hot Swap control and Power over Ethernet devices for use in applications ranging from Consumer and Industrial to Automotive.

SMARTMOS™ — Freescale Semiconductor SMARTMOS technology allows designers to interface high-precision components with the harsh automotive environment..

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POWER MANAGEMENT PRODUCTS

Power Management — Linear Regulators

Product	Description	Main Characteristics	Bus Type and Standard	Operating Voltage (V)	Current Limitation Standby (μA)		Other Features	Diagnostics ¹	Protection Features	Packaging	Status
					Typ	Max					
MC33730	Switch Mode Power Supply with Multiple Linear Regulators and Power Sequencing	Step-down Switching regulator (2.0 A), with 3 Programmable Linear Regulators (15 mA, 15 mA, 15 mA) and two 5.0 V Sensor supplies (100 mA, 100 mA).	n/a	4.5 to 28	150	—	Programmable voltage regulator, power sequencing, adjustable OSC - Switcher	None	Reverse Battery Protect, Undervoltage and Overvoltage Lockout, Reset monitor signals for regulators (4)	32-pin SOICW	Production EVB
MC33742	System Basis Chip with enhanced High-Speed CAN (250k to 1Mbps)	See System Basis Chip (Page 10)									
MC33889	System Basis Chip with Low-Speed Fault Tolerant CAN										
MC33903	System Basis Chip(SBC)-Gen 2-with High Speed CAN & LIN Interfaces										
MC33904	System Basis Chip(SBC)-Gen 2-with High Speed CAN Interfaces										
MC33905	System Basis Chip(SBC)-Gen 2-with High Speed CAN & LIN Interfaces										
MC33989	System Basis Chip with High-Speed CAN										

1. Products available with SPI Control work with the KITUSBSPIEVME and the KITUSBSPIDGLEVME USB-SPI Interface Boards.

Power Management — Switching Regulators

Product	Description	Main Characteristics	Operating Voltage (V)	Output Voltages	Protection Features	Packaging	Status
MC33730	Switch Mode Power Supply with Multiple Linear Regulators and Power Sequencing	Step-down Switching regulator (2.0 A), with 3 Programmable Linear Regulators (15 mA, 15 mA, 15 mA) and 2 x 5.0 V sensor supply (100 mA, 100 mA)	4.5 to 28	4.9 to 5.1 V, 2.0 to 3.3 V, 1.5 to 3.3 V, 1.0 to 5.0 V, 5.0 V	Reverse Battery Protect, Undervoltage and Overvoltage Lockout, Reset monitor signals for regulators (4)	32-pin SOICW	Production EVB



ANALOG AND MIXED-SIGNAL PRODUCTS (continued)

Automotive Alternator Voltage Regulators (LIN 1.3 protocol compliant)

Product	Description	Main Characteristics	Bus Type	Operating Voltage (Vdc)	Regulation Voltage (VDC)	Other Features	Diagnostics	Protection Features	Packaging	Status
TC80310	An integrated circuit intended to regulate the output voltage of an automotive alternator. It supplies a current via a high side MOSFET to the excitation coil of the alternator and provides an internal free-wheeling diode.	High side field driver, Internal freewheeling diode, Up to 8.0 A rotor current (excitation coil), Load response control (LRC), LIN interface, Set point voltage selectable	LIN	8 to 27	150	Factory Selectable Features: LRC Rate, LRC disable RPM, Self start, Self start threshold, Alternator Pole pairs, Thermal Fault Threshold, Thermal Compensation Threshold, Phase Sensitivity, Phase Start Regulating RPM, Phase Stop Regulating RPM	LIN communication used for Electrical, Mechanical and Thermal fault reporting	Load Dump Protection, Thermal protection, Thermal compensation	Die	Production

Note: Choice of 16 parametric fields may be specified by the customer. Contact sales for specific parameter combinations and part numbering.



FREESCALE SEMICONDUCTOR AUTOMOTIVE SENSORS

Freescale is a leading sensor supplier for automotive safety for airbags, Tire Pressure Monitoring Systems (TPMS), Electronic Stability Control (ESC) and for engine management with barometric absolute pressure (BAP) and manifold absolute pressure (MAP) applications..

Our Zero Defects process, Automotive Electronics Council (AEC) membership and functional safety with Safe Assure are critical in providing world-class quality solutions from entry-level to the high end.

Applications — Freescale Semiconductor automotive sensors are designed for a variety of applications ranging from safety and performance to comfort and control. Our sensors are used in under-hood and in-cabin applications, and are compatible with Freescale analog product, power management and microcontroller families.

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AUTOMOTIVE SENSORS

Pressure Sensors

Product	Maximum Pressure Rating (kPa)	Full Scale Span Voltage (Typical) (Vdc)	Sensitivity (mV/kPa)	Accuracy 0°C to 85°C (% of V _{FSS})	Packaging	Status
MPX4100A	105	4.6	54	±1.8	Small Outline Package (SOP)	Available
MPXAZ4100A	105	4.6	54	±1.8	SOP — media resistant package	Available
MPX4115	115	4.6	46	±1.5	Super-Small Outline Package (SSOP)	Available
	115	4.4	38	±1.5		SSOP
MPX4250	250	4.7	20	±1.5	SSOP	Available
	250	4.7	19	±1.4	SSOP	Available
MPXV5004	4	3.9	1000	±2.5	SOP	Available
MPXV5010G	10	4.5	450	±5.0	SOP	Available
MPX5100	100	4.5	45	±2.5	6-pin unibody package	Available
MPX5700	700	4.5	6.4	±2.5	6-pin unibody package	Available
MPX5999D	1000	4.5	4.5	±2.5	6-pin unibody package	Available
MPXH6101	102	4.6	54	±1.8	SSOP	Available
MPXV6115V	115	4.6	45.9	±1.5	SOP	Available
MPXV7007	7	4.0	286	±5.0	SOP	Available
MPXV7025	25	4.5	90	±5.0	SOP	Available

Barometric Absolute Pressure (BAP) and Manifold Absolute Pressure (MAP) Sensors

Product	Maximum Pressure Rating (kPa)	Full Scale Span Voltage (Typical) (Vdc)	Sensitivity (mV/kPa)	Accuracy 0°C to 85°C (% of V _{FSS})	Packaging	Status
MPXH6101A	102	4.6	54	±1.8	Super-Small Outline Package (SSOP)	Available
MPXA6115A	115	4.6	45.9	±1.5	SOP	Available
MPXAZ6115A	115	4.5	45.9	±1.5	SOP	Available
MPXHZ6115	115	4.5	45.9	±1.5	SSOP	Available
MPXHZ6115A	115	4.5	45.9	±1.5	SSOP	Available
MPXH6250A	250	4.7	20	±1.5	SSOP	Available
MPXHZ6250	250	4.7	20	±1.5	SSOP	Available
MPXH6300	300	4.7	16	±1.8	SSOP	Available
MPXH6400	400	4.7	12	±1.5	SSOP	Available
MPXHZ6400	400	4.7	12	±1.5	SSOP	Available
MPXHZ9115A6T1	115	4.5	45	±1.5	SSOP	3Q2013
MPXHZ9250A6T1	250	4.5	19.1	±1.5	SSOP	3Q2013
MPXHZ9400A6T1	400	4.5	11.7	±1.5	SSOP	3Q2013
MPXHZ9105A6T1	105	4.5	50	±1.5	SSOP	3Q2013
MPXHZ9115AC6T1	115	4.5	45	±1.5	SSOP	3Q2013
MPXHZ9250AC6T1	250	4.5	19.1	±1.5	SSOP	3Q2013
MPXHZ9400AC6T1	400	4.5	11.7	±1.5	SSOP	3Q2013



AUTOMOTIVE SENSORS (continued)

Inertial Sensors¹

Product	Sensing Direction	Acceleration (±g)	Sensitivity (mV/V/g)	Sensitivity (count/g)	Temperature Range	Roll-Off Frequency	Analog	Digital	Communication	Packaging	Status
Analog Sensors:											
MMA1260KEG	Z	1.5g	240	—	-40°C to +105°C	50 Hz	Yes	—	—	16-pin SOIC	Available
MMA1270KEG	Z	2.5g	150	—	-40°C to +105°C	50 Hz	Yes	—	—	16-pin SOIC	Available
MMA1250KEG	Z	5g	80	—	-40°C to +105°C	50 Hz	Yes	—	—	16-pin SOIC	Available
MMA1220KEG	Z	8g	50	—	-40°C to +85°C	250 Hz	Yes	—	—	16-pin SOIC	Available
MMA2240KEG	X	7g	300	—	-40°C to +125°C	50 Hz	Yes	—	—	16-pin SOIC	Available
MMA2244KEG	X	20g	100	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA2201KEG	X	40g	10	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA2202KEG	X	50g	8	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA2204KEG	X	100g	4	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA2300KEG	X	250g	1.6	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA2301KEG	X	200g	2	—	-40°C to +125°C	400 Hz	Yes	—	—	16-pin SOIC	Available
MMA3201KEG	XY	40g	10	—	-40°C to +125°C	400 Hz	Yes	—	—	20-pin SOIC	Available
MMA3221KEG	XY	50/20	40/100	—	-40°C to +125°C	400 Hz	Yes	—	—	20-pin SOIC	Available
MMA3204KEG	XY	100/30g	4/13	—	-40°C to +125°C	400 Hz	Yes	—	—	20-pin SOIC	Available
MMA3202KG	XY	100/50g	4/8	—	-40°C to +125°C	400 Hz	Yes	—	—	20-pin SOIC	Available
MMA621010KEG	XY	100/100	4.68/4.68	—	-40°C to +125°C	400 Hz	Yes	—	—	20-pin SOIC	Available
Digital Sensors:											
MMA5106KW	Z	60g	—	8	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5112KW	Z	120g	—	4	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5124KW	Z	240g	—	2	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5148KW	Z	480g	—	1	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5206KW	X	60g	—	8	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5212KW	X	120g	—	4	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5224KW	X	240g	—	2	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA5248KW	X	480g	—	1	-40°C to +125°C	400 Hz	—	Yes	PSI5	16-pin QFN	Available
MMA2602KW	X	25g	—	20.48	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA2605KW	X	50g	—	10.24	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA2606KW	X	62.5g	—	8.192	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA2612KW	X	125g	—	4.096	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA2618KW	X	187g	—	2.731	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA2631KW	X	312g	—	1.638	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA1605KW	Z	50g	—	10.24	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA1606KW	Z	62.5g	—	8.192	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA1612KW	Z	125g	—	4.096	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA1618KW	Z	187g	—	2.731	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available

1. Freescale Semiconductor reserves the right to modify product specifications and/or introduction dates without any further notice. The product parameters are typical values at $V_{DD} = 5\text{ V}$ and $T = 25^\circ\text{C}$, unless otherwise specified.

Additional sensitivity and expanded temperature ranges are available upon request. Consult your Freescale Semiconductor sales representative

Inertial Sensors¹

Product	Sensing Direction	Acceleration (±g)	Sensitivity (mV/V/g)	Sensitivity (count/g)	Temperature Range	Roll-Off Frequency	Analog	Digital	Communication	Packaging	Status
MMA1631KW	Z	312g	—	1.638	-40°C to +125°C	400 Hz	—	Yes	DSI	16-pin QFN	Available
MMA6255KEG	XY	50/50	—	9.76	-40°C to +125°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6851KQ	X	25g	—	20.479	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6852KQ	X	35g	—	13.947	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6853KQ	X	50g	—	9.766	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6854KQ	X	75g	—	6.51	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6855KQ	X	120g	—	4.096	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6856KQ	X	60g	—	8.192	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6811KQ	XY	60g/25g	—	8.192/20.479	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6813KQ	XY	50g/50g	—	9.766/9.766	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6821KQ	XY	120g/25g	—	4.096/20.479	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6823KQ	XY	120g/60g	—	4.096/8.192	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6826KQ	XY	60g/60g	—	8.192/8.192	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6827K	XY	120g/120g	—	4.096/4.096	-40°C to +105°C	400 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6900KQ	XY	3.5g	—	291.5	-40°C to +105°C	50 Hz	—	Yes	SPI	16-pin QFN	Available
MMA6901KQ	XY	5g	—	203.6	-40°C to +105°C	50 Hz	—	Yes	SPI	16-pin QFN	Available

1. Freescale Semiconductor reserves the right to modify product specifications and/or introduction dates without any further notice. The product parameters are typical values at $V_{DD} = 5\text{ V}$ and $T = 25^\circ\text{C}$, unless otherwise specified.

Additional sensitivity and expanded temperature ranges are available upon request. Consult your Freescale Semiconductor sales representative.



AUTOMOTIVE SENSORS (continued)

Tire Pressure Monitoring Systems

Product	Flash	RAM	RF Transmitter Frequency	Protocols Supported	Clock Type	Timer	Pressure Range	Pressure Sensor Accuracy	Package	Temperature Range	Status	Description
MPXY8600A	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 800 kPa	±10 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (with XZ-Axis Accelerometer)
MPXY8500B	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 800 kPa	±10 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (with Z-Axis Accelerometer)
MPXY8500C	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 800 kPa	±10 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (without an Accelerometer)
MPXY8610A	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 450 kPa	±7 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (with XZ-Axis Accelerometer)
MPXY8510B	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 450 kPa	±7 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (with Z-Axis Accelerometer)
MPXY8350C	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 450 kPa	±7 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Automotive Pressure Range (without an Accelerometer)
MPXY8620A	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 1500 kPa	±20 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Truck Tire Pressure Range (with XZ-Axis Accelerometer)
MPXY8620B	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 1500 kPa	±20 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Truck Tire Pressure Range (with Z-Axis Accelerometer)
MPXY8620C	16 KB	512 B	315/434MHz	ASK and FSK Modulation	OSC	2-CH, 16-bit PWM	100 - 1500 kPa	±20 kPa	SOIC-20 WB	-40 to 125°C	Contact Freescale	Truck Tire Pressure Range (without an Accelerometer)

FREESCALE SEMICONDUCTOR ACCESS AND REMOTE CONTROL PRODUCTS

For additional information, visit:

Documentation, Tool, and Product Libraries
www.freescale.com

Automotive Home Page
www.freescale.com/automotive

ACCESS AND REMOTE CONTROL PRODUCTS

GPS Downconverter

Product	RF Freq (MHz)	Supply Voltage Range (Vdc)	Supply Current (Typ) (mA)	Standby Current (mA)	Conversion Gain (typ) (dB)	Packaging	System Applicability	Documentation
MRFC1505A	1575.42	2.7 to 3.3	28	3	105	48-pin LQFP (Case No 932)	GPS	MRFC1505

FREESCALE SEMICONDUCTOR LOCAL INTERCONNECT NETWORK (LIN) SOLUTIONS

Freescale Semiconductor and LIN—As the only semiconductor member of the LIN consortium, Freescale Semiconductor has the industry's most advanced range of components, software, tools, and support available.

Cost Benefits from LIN—A LIN sub-bus system uses a single-wire implementation and self-synchronization, without a crystal or ceramic resonator, in the slave node. With these cost benefits, high-end comfort and convenience features no longer need to be limited only to top-of-the-line cars.

Embedded Controllers—Since the LIN sub-bus is based on common UART/SCI interface hardware, the 8-bit 68HC08, and 16-bit S12 and S12X Families provide the industry's broadest range of performance and features, affording designers the freedom to choose parts ideally suited to their needs.

Advanced Integration with LIN—Microcontrollers will evolve in the LIN environment to integrate the voltage regulator, physical interface, and high-voltage I/O to provide space, cost, and reliability benefits. Freescale Semiconductor solutions provide this capability today.

Software for LIN—Freescale Semiconductor is working closely with the leading LIN tool supplier to ensure a first class, seamless development and debug environment for Freescale Semiconductor LIN products.

For additional information, visit:

Local Interconnect Network (LIN) Home Page

www.lin-subbus.org

Automotive Home Page

LIN Software Products

Product	68HC05	68HC08	S08	S12	S12X
LIN master	n/a	Available	Available	Available	Available
LIN slave	Available	Available	Available	Available	Available
Operating system	n/a	Available	Available	Available	Available

LIN Physical Layer Transceivers

Product	Description	Main Characteristics	Bus Type and Standard	Protection Features	Operating Voltage (V)	Current Limitation Standby (μA)		Other Features	Control and Status Reporting	Packaging	Status
						Typ	Max				
MC33399	See <i>Network Transceivers — LIN, ISO-9141, J-1850 Physical Interface Components</i> (page 8)										
MC33661	See <i>Network Transceivers — LIN, ISO-9141, J-1850 Physical Interface Components</i> (page 8)										
MC33662	See <i>Network Transceivers — LIN, ISO-9141, J-1850 Physical Interface Components</i> (page 8)										



MCU CHOICES BY APPLICATION

Application	Microcontroller
Transmission, Engine Control and Management Interfaces	MPC5674F, MPC5673F, MPC563xM, MPC5644A, MPC5643A, MPC5642A,, MPC5746M, MPC5777M, S12XE, S12P, S12G
Hybrid and Electric Auxillaries	MPC5674F, MPC5673F, MPC563xM, MPC5644A, MPC5643A, MPC5642A, MPC5744P, MPC5746G, MPC5747C, MPC5747G, MPC5748C, MPC55748G, MPC5746M, S12G
Watchdog	S12G, S12P , <i>S08QD4, S08SG, S08AW, S08SC4, S08RN</i>
High Temperature	MPC5744P, S12G , <i>S08SG</i>
Body Control Module and Gateway	MPC5668x, MPC560xB, MPC560xD, MPC564xB/C, MPC5746G, MPC5747C, MPC5747G, MPC5748C, MPC5748G, S12G, S12XE
HVAC, Lighting, Seats, Window Lift, Doors, Sun Roof	MPC560xB, MPC560xD, S12XS, S12P, S12G, S12VR, S12ZVFP , <i>S08D, S08AW, S08EL, S08SG, S08SL, S08MP16, S08SC4, S08RN</i>
Body Motor Control	S12G, S12VR , <i>S08MP16, S08RN</i>
Infotainment	all i.MX, SVFxxxR
Telematics	i.MX251, i.MX281, i.MX53, i.MX351, i.MX 6S1, i.MX 6U1
Instrument Cluster	MPC560xS, i.MX534, i.MX 6S1, i.MX 6U1, SVFxxxR, S12H, S12XH, S12XHY, S12ZVFP, S12ZVH, S12ZVY <i>S08LG</i> ,
Braking Systems	MPC564xL, MPC560xP, MPC5744P, S12XE, S12XS
Electronic Power Steering	MPC564xL, MPC560xP, MPC5744P, S12G
Semi-Active Suspension	MPC564xL, MPC5744P
Airbag	MPC560xP, MPC5744P, S12XF, S12XE, S12XS , <i>S08SG</i>
Electronic Stability Control	MPC564xL, MPC560xP, MPC5744P
Lane Departure	i.MX534, MPC567xK, i.MX 6S4, i.MX 6U4, i.MX 6D4, i.MX 6Q4
Advanced Cruise Control	MPC564xL, MPC567xK, MPC5744P, SCP2201, SCP2207
Pre-crash, Blindspot Detection, Backup Warning	MPC564xL, MPC567xK, MPC5744P, MPC5604E, S12ZVFP , <i>S08RN</i>
Ethernet	MPC560xS, MPC5668x, MPC5746G, MPC5747C, MPC5747G, MPC5748C, MPC5748G, MPC5746M, all i.MX
FlexRay (tm)	MPC5668x, MPC564xL, MPC560xP, MPC5674F, MPC5673F, MPC5644A, MPC5643A, MPC5642A, MPC5744P, MPC5748G, MPC5747C, MPC5747G, MPC5748C, MPC5748G, MPC5746M MPC5642A, S12XF
CAN	all MPC5xxx, MPC5644A, MPC5643A, MPC5642A, MPC5744P, MPC5746G,, MPC5747C, MPC5747G, MPC5748C, MPC5748G, MPC5746M all S12(X) , <i>S08D</i>
LIN	MPC5644P, MPC5746G, MPC5747C, MPC5747G, MPC5748C, MPC5748G, S12P, S12XS, S12XE, S12G, S12X, S12VR64 , <i>S08SG, S08EL, S08AW, S08D, S08SL, S08SC4, S08RN</i>
vr	NOTE: 32-bit in plain, 16-bit in bold , <i>8-bit in italics</i>



S08 8 - BIT MICROCONTROLLERS

S08 Core Technology — Optimized for extreme operating economy with a number of low-power options, Freescale's S08 core is particularly attractive for automotive applications. Multiple stop modes, along with wait and standby modes, will help achieve new thresholds in low-power performance under a variety of operating conditions. The S08 core allows efficient, compact, modular coding with full 16-bit stack-pointer and stack-relative addressing, which permit various instruction sizes and enable memory interface in multiple mechanisms and addressing modes. The object code is also compatible with Freescale's legacy HC05 and HC08 cores.

S08 Family Benefits — Freescale's S08 families help save cost, reduce board space, increase performance and improve quality through extensive on-chip integration. No longer are external components required, such as an external crystal, LVI circuit, voltage regulator, I/O mux, watchdog circuit or EEPROM. With on-chip emulation and debug, changes can be made in application and in real-time, reducing development time. Also, with the S08 CPU running at 40 MHz, MCUs are able to quickly accomplish a task and go back to sleep. Quick execution translates into power savings, which allows customers to add more embedded content while staying within their power bud-

S08 Families (Sheet 1 of 3)

Device	Bus Frequency	Flash	RAM	EEPROM	CAN	UART	SPI	I ² C	SLIC	Analog (ADC)	Timer	Clock	Additional Features	Operating Voltage	Temp. Range ¹	Package Options	In Production
S08DZ128	20 MHz	128 KB	8 KB	Up to 2 KB	1	2xSCI	2	2	—	24-CH, 12-bit ADC, 2 comparators	Up to 12-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	√
S08DZ96	20 MHz	96 KB	6 KB	Up to 2 KB	1	2xSCI	2	2	—	24-CH, 12-bit ADC, 2 comparators	Up to 12-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	√
S08DZ60	20 MHz	60 KB	4 KB	Up to 2 KB	1	2xSCI	1	1	—	Up to 24-CH, 12-bit ADC, 2 comparators	Up to 6-CH+2-CHCH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DZ48	20 MHz	48 KB	3 KB	Up to 1.5 KB	1	2xSCI	1	1	—	Up to 24-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DZ32	20 MHz	32 KB	2 KB	Up to 1 KB	1	2xSCI	1	1	—	Up to 24-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DZ16	20 MHz	16 KB	1 KB	Up to 512B	1	2xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP	√
S08DV128	20 MHz	128 KB	6 KB	—	1	2xSCI	2	2	—	24-CH, 12-bit ADC, 2 comparators	Up to 12-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	√
S08DV96	20 MHz	96 KB	4 KB	—	1	2xSCI	2	2	—	24-CH, 12-bit ADC, 2 comparators	Up to 12-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	√
S08DV60	20 MHz	60 KB	3 KB	—	1	2xSCI	1	1	—	Up to 16-CH, 12-bit ADC, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DV48	20 MHz	48 KB	2 KB	—	1	2xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DV32	20 MHz	32 KB	2 KB	—	1	2xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DV16	20 MHz	16 KB	1 KB	—	1	1xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP	√
S08DN60	20 MHz	60 KB	2 KB	Up to 2 KB	—	1xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DN48	20 MHz	48 KB	2 KB	Up to 1.5 KB	—	1xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√



S08 Families (Sheet 2 of 3)

Device	Bus Frequency	Flash	RAM	EEPROM	CAN	UART	SPI	I ² C	SLIC	Analog (ADC)	Timer	Clock	Additional Features	Operating Voltage	Temp. Range ¹	Package Options	In Production
S08DN32	20 MHz	32 KB	1 KB	Up to 1 KB	—	1xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP, 64 LQFP	√
S08DN16	20 MHz	16 KB	512 B	Up to 512B	—	1xSCI	1	1	—	Up to 16-CH, 12-bit, 2 comparators	Up to 6-CH+2-CH	MCG (PLL, FLL, OSC)	Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	32 LQFP, 48 LQFP	√
S08AW60	20 MHz	60 KB	2 KB	—	—	2xSCI	1	1	—	Up to 16-CH, 10-bit	Up to 6-CH+2-CH	ICG	KBI, ICE, BDM, Temp Sensor	2.7 to 5.5	C, V, M	64 QFP, 64 LQFP, 48 QFN, 44 LQFP	√
S08AW48	20 MHz	48 KB	2 KB	—	—	2xSCI	1	1	—	Up to 16-CH, 10-bit	Up to 6-CH+2-CH	ICG	KBI, ICE, BDM, Temp Sensor	2.7 to 5.5	C, V, M	64 QFP, 64 LQFP, 48 QFN, 44 LQFP	√
S08AW32	20 MHz	32 KB	2 KB	—	—	2xSCI	1	1	—	Up to 16-CH, 10-bit	Up to 6-CH+2-CH	ICG	KBI, ICE, BDM, Temp Sensor	2.7 to 5.5	C, V, M	64 QFP, 64 LQFP, 48 QFN, 44 LQFP	√
S08AW16A	20 MHz	16 KB	1 KB	—	—	2xSCI	1	1	—	Up to 8-CH, 10-bit	Up to 8-CH	ICG	KBI, ICE, BDM, Temp Sensor	2.7 to 5.5	C, V, M	48 QFN, 44 QFP, 32 LQFP	√
S08AW8A	20 MHz	8 KB	768 B	—	—	2xSCI	1	1	—	Up to 8-CH, 10-bit	Up to 8-CH	ICG	KBI, ICE, BDM, Temp Sensor	2.7 to 5.5	C, V, M	48 QFN, 44 QFP, 32 LQFP	√
S08EL32	20 MHz	32 KB	1 KB	Up to 512 B	—	1xSCI	1	1	1	Up to 16-CH, 10-bit, 2 comparators	4-CH+2-CH	ICS	LIN Auto-Baud/Synch, 40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	28 TSSOP, 20 TSSOP	√
S08EL16	20 MHz	16 KB	1 KB	Up to 512 B	—	1xSCI	1	1	1	Up to 16-CH, 10-bit, 2 comparators	4-CH+2-CH	ICS	LIN Auto-Baud/Synch, 40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	28 TSSOP, 20 TSSOP	√
S08SL16	20 MHz	16 KB	512 B	Up to 256 B	—	1xSCI	1	1	1	Up to 16-CH, 10-bit, 1 comparator	2-CH+2-CH	ICS	LIN Auto-Baud/Synch, 40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	28 TSSOP, 20 TSSOP	√
S08SL8	20 MHz	8 KB	512 B	Up to 256 B	—	1xSCI	1	1	1	Up to 16-CH, 10-bit, 1 comparator	2-CH+2-CH	ICS	LIN Auto-Baud/Synch, 40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	28 TSSOP, 20 TSSOP	√
S08SG32	20 MHz	32 KB	1 KB	—	—	1xSCI	1	1	—	Up to 16-CH, 10-bit, 1 comparator	2-CH+2-CH	ICS	40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M, J, W	28 TSSOP, 20 TSSOP, 16 TSSOP	√
S08SG16	20 MHz	16 KB	1 KB	—	—	1xSCI	1	1	—	Up to 16-CH, 10-bit, 1 comparator	2-CH+2-CH	ICS	40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M, J, W	28 TSSOP, 20 TSSOP, 16 TSSOP	√
S08SG8	20 MHz	8 KB	512 B	—	—	1xSCI	1	1	—	Up to 12-CH, 10-bit, 1 comparator	Up to 2-CH+2-CH	ICS	40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	20 TSSOP, 16 TSSOP, 8 SOIC	√
S08SG4	20 MHz	4 KB	256 B	—	—	1xSCI	1	1	—	Up to 12-CH, 10-bit, 1 comparator	Up to 2-CH+2-CH	ICS	40 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	20 TSSOP, 16 TSSOP, 8 SOIC	√
S08SC4	20MHz	4 KB	256 B	—	—	1xSCI	—	—	—	8-CH, 10-bit	2-CH, 16-bit with PWM functions	ICS	40 MHz CPU, Watchdog, COP, Internal Clock Generator, OSC/Timer KBI, Low Voltage Detect, POR, BDM, Temp Sensor	4.5 to 5.5	C, V, M	16 TSSOP	√

S08 Families (Sheet 3 of 3)

Device	Bus Frequency	Flash	RAM	EEPROM	CAN	UART	SPI	I ² C	SLIC	Analog (ADC)	Timer	Clock	Additional Features	Operating Voltage	Temp. Range ¹	Package Options	In Production
S08LG32	20 MHz	32 KB	2 KB	—	—	2xSCI	1	1	—	Up to 16-CH, 12-bit	Up to 2-CH+6-CH	ICS	40 MHz CPU, Up to 37x8/41x4 LCD Driver, Watchdog OSC/Timer, RTC, KBI, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V	80 LQFP, 64 LQFP, 48 LQFP	√
S08LG16	20 MHz	18 KB	2 KB	—	—	2xSCI	1	1	—	Up to 16-CH, 12-bit	Up to 2-CH+6-CH	ICS	40 MHz CPU, Up to 29x8/33x4 LCD Driver, Watchdog OSC/Timer, RTC, KBI, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V	64 LQFP, 48 LQFP	√
S08MP16	20MHz	16 KB	1 KB	—	—	1xSCI	1	1	—	13-CH, 12-bit, 3 comparators	6-CH+2-CH, 16-bit FlexTimer with PWM functions	ICS	40 MHz CPU, PGA, PDB (x2), MTIM, RTC, POR, KBI, COP, CRC, ICE, BDM, 5-bit DAC (3x), Temp Sensor	2.7 to 5.5	C, V, M	48 LQFP	√
S08RN60	20MHz	60 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH + 2-CH	ICS	TSI, Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08RN48	20MHz	48 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH	ICS	TSI, Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08RN32	20MHz	32 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH	ICS	TSI, Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08RN16	20MHz	16 KB	2 KB	256 B	—	2	1	1	—	12-CH, 12-bit	6-CH + 2-CH	ICS	TSI, Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	48,32 LQFP; 20, 16 TSSOP	√
S08RN8	20MHz	8 KB	2 KB	256 B	—	2	1	1	—	12-CH, 12-bit	6-CH + 2-CH	ICS	TSI, Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	48,32 LQFP; 20, 16 TSSOP	√
S08RNA4	20MHz	4 KB	512 B	128 B	—	1	—	—	—	8-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	20, 16 TSSOP; 20 SOIC	√
S08RNA2	20MHz	2 KB	512 B	128 B	—	1	—	—	—	8-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	20, 16 TSSOP; 20 SOIC	√
S08RNA8	20MHz	8 KB	2 KB	256 B	—	2	1	1	—	12-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	48,32 LQFP; 20, 16 TSSOP	√
S08RNA16	20MHz	16 KB	2 KB	256 B	—	2	1	1	—	12-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	48,32 LQFP; 20, 16 TSSOP	√
S08RNA32	20MHz	32 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08RNA48	20MHz	48 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08RNA60	20MHz	60 KB	4 KB	256 B	—	3	2	1	—	16-CH, 12-bit	6-CH + 2-CH + 2-CH	ICS	Watchdog, BDM, RTC, Analog Comparator	2.7 to 5.5	C, V, M	64, 48,32 LQFP	√
S08QD4	8 MHz	4 KB	256 B	—	—	—	—	—	—	4-CH, 10-bit	2-CH+1-CH	ICS	16 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	8 SOIC	√
S08QD2	8 MHz	2 KB	128 B	—	—	—	—	—	—	4-CH, 10-bit	2-CH+1-CH	ICS	16 MHz CPU, Watchdog OSC/Timer, COP, LVI, ICE, BDM, POR, KBI, Temp Sensor	2.7 to 5.5	C, V, M	8 SOIC	√

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C



S12 AND S12X 16-BIT MICROCONTROLLERS

S12 and S12X Cores — The S12X family offers 32-bit performance with all of the advantages and efficiencies of a 16-bit MCU. Based on the S12 core, S12X devices deliver 2 to 5 times the performance of a 25 MHz S12 MCU, while retaining code compatibility for easy migration. 172 additional instructions were added to the S12X core to improve paging capability and execute 32-bit calculations.

Furthermore, S12X devices offers an industry first-the XGATE module. This versatile, efficient coprocessor delivers up to 80 MIPS of additional processing power to off-load, from the main CPU, tasks such as basic gateway activity and peripheral-related processing. The parallel architecture enables more deterministic handling of interrupts

and allows design engineers to avoid conflict between core functions and interrupt processing.

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S12 and S12X Families

Device	Bus Frequency	Flash	RAM	Data Flash	EEPROM	XGATE	MPU	ECC	FlexRay	CAN	SCI	SPI	I ² C	Analog (ADC)	PWM	Motor	SSD	ECT	Timer	PIT	LCD	KWU	EBI	Operating Voltage	Temp. Range ¹	Package Options	In Production
S12XEP100	50 MHz	1 MB	64 KB	—	4 KB	✓	✓	✓	—	5	8	3	2	2x16-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	8-CH, 16-bit	8-CH	—	25	✓	3.13 to 5.5	C, V, M	112 LQFP, 144 LQFP, 208 MAPBGA	✓
S12XEP768	50 MHz	768 KB	48 KB	—	4 KB	✓	✓	✓	—	5	8	3	2	2x16-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	8-CH, 16-bit	8-CH	—	25	✓	3.13 to 5.5	C, V, M	112 LQFP, 144 LQFP, 208 MAPBGA	✓
S12XEQ512	50 MHz	512 KB	32 KB	—	4 KB	✓	✓	✓	—	4	6	3	2	2x12-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	8-CH, 16-bit	8-CH	—	25	✓	3.13 to 5.5	C, V, M	80 LQFP, 112 LQFP, 144 LQFP	✓
S12XEQ384	50 MHz	384 KB	24 KB	—	4 KB	✓	✓	✓	—	4	4	3	1	2x12-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	4-CH	—	25	✓	3.13 to 5.5	C, V, M	80 LQFP, 112 LQFP, 144 LQFP	✓
S12XET512	50 MHz	512 KB	32 KB	—	4 KB	✓	✓	✓	—	3	6	3	2	24-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 4-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP, 112 LQFP, 144 LQFP	✓
S12XET384	50 MHz	384 KB	24 KB	—	4 KB	✓	✓	✓	—	3	6	3	2	24-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 4-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP, 112 LQFP, 144 LQFP	✓
S12XET256	50 MHz	256 KB	16 KB	—	4 KB	✓	✓	✓	—	3	4	3	1	2x12-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	4-CH	—	25	✓	3.13 to 5.5	C, V, M	80 LQFP, 112 LQFP, 144 LQFP	✓
S12XEG384	50 MHz	384 KB	24 KB	—	4 KB	✓	✓	✓	—	2	6	3	2	24-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 4-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP, 112 LQFP, 144 LQFP	✓
S12XEG256	50 MHz	256 KB	16 KB	—	4 KB	✓	✓	✓	—	2	4	3	1	16-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 4-CH	—	25	✓	3.13 to 5.5	C, V, M	112 LQFP	✓
S12XEG128	50 MHz	128 KB	12 KB	—	2 KB	✓	✓	✓	—	2	2	2	1	16-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 2-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP, 112 LQFP	✓
S12XEA256	54 MHz	256 KB	16 KB	—	4 KB	✓	✓	✓	—	3	2	3	1	8-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 8-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP	✓
S12XEA128	50 MHz	128 KB	12 KB	—	2 KB	✓	✓	✓	—	2	2	2	1	12-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 8-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP	✓
S12XES384	55 MHz	384 KB	24 KB	—	4 KB	✓	✓	✓	—	1	2	1	1	16-CH, 12-bit	8-CH, 8-bit	—	—	8-CH, 16-bit	—	Up to 8-CH	—	25	✓	3.13 to 5.5	C, V, M	80 QFP, 112 LQFP, 144 LQFP	✓
S12GA128	25 mHz	128 KB	8 KB	—	4 KB	—	—	✓	—	1	3	3	—	12-CH, 12-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	✓
S12GA96	25 mHz	96 KB	8 KB	—	4 KB	—	—	✓	—	1	3	3	—	12-CH, 12-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M	48 LQFP, 64 LQFP, 100 LQFP	✓
S12GA64	25 mHz	64 KB	4 KB	—	2 KB	—	—	✓	—	1	2	2	—	12-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	48 LQFP, 64 LQFP	✓



S12 and S12X Families

Device	Bus Frequency	Flash	RAM	Data Flash	EEPROM	XGATE	MPU	ECC	FlexRay	CAN	SCI	SPI	i ² C	Analog (ADC)	PWM	Motor	SSD	ECT	Timer	PIT	LCD	KWU	EBI	Operating Voltage	Temp. Range ¹	Package Options	In Production
S12G64	25 mHz	64 KB	4 KB	—	2 KB	—	—	√	—	1	2	2	—	12-CH, 10-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	32 LQFP, 48 LQFP, 64 LQFP	√
S12GA48	25 mHz	48 KB	4 KB	—	1.5 KB	—	—	√	—	1	2	2	—	12-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	48 LQFP, 64 LQFP	√
S12G48	25 mHz	48 KB	4 KB	—	1.5 KB	—	—	√	—	1	2	2	—	12-CH, 10-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	32 LQFP, 48 LQFP, 64 LQFP	√
S12GNA48	25 mHz	48 KB	4 KB	—	1.5 KB	—	—	√	—	—	2	2	—	12-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	48 LQFP, 64 LQFP	√
S12GN48	25 mHz	48 KB	4 KB	—	1.5 KB	—	—	√	—	—	2	2	—	12-CH, 10-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	32 LQFP, 48 LQFP, 64 LQFP	√
S12GNA32	25 mHz	32 KB	2 KB	—	1 KB	—	—	√	—	—	1	1	—	8-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	48 LQFP	√
S12GN32	25 mHz	32 KB	2 KB	—	1 KB	—	—	√	—	—	1	1	—	8-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	20 TSSOP, 32 LQFP, 48 LQFP, 48 QFN	√
S12GNA16	25 mHz	16 KB	1 KB	—	512 B	—	—	—	—	—	1	1	—	8-CH, 12-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	48 LQFP	√
S12GN16	25 mHz	16 KB	1 KB	—	512 B	—	—	√	—	—	1	1	—	8-CH, 10-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	16	—	3.13 to 5.5	C, V, M, W	20 TSSOP, 32 LQFP, 48 LQFP, 48 QFP	√
S12G192	25 MHz	192 KB	11 KB	—	4 KB	—	—	√	—	1	3	3	—	16-CH, 10-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	—	—	3.13 to 5.5	M	20 TSSOP, 32 LQFP, 48 LQFP, 48 QFN, 64 LQFP, 100 LQFP	√
S12G240	25 MHz	240 KB	11 KB	—	4 KB	—	—	√	—	1	3	3	—	16-CH, 10-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	—	—	3.13 to 5.5	M	20 TSSOP, 32 LQFP, 48 LQFP, 48 QFN, 64 LQFP, 100 LQFP	√
S12GN32	25 MHz	32 KB	2 KB	—	1 KB	—	—	√	—	—	1	1	—	8-CH, 10-bit	6-CH, 8-bit	—	—	—	6-CH, 16-bit	—	—	—	—	3.13 to 5.5	M	20 TSSOP, 32 LQFP, 48 LQFP, 48 QFN, 64 LQFP, 100 LQFP	√
S12G128	25 MHz	128 KB	8 KB	—	4 KB	—	—	—	—	1	3	3	—	12-CH, 10-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	—	—	3.13 to 5.5	M	48 LQFP, 64 LQFP, 100 LQFP	√
S12G96	25 MHz	96 KB	8 KB	—	3 KB	—	—	—	—	1	3	3	—	12-CH, 10-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	—	—	3.13 to 5.5	M	48 LQFP, 64 LQFP, 100 LQFP	√
S12XS256	40 MHz	256 KB	12 KB	8 KB	—	—	—	√	—	1	2	1	—	16-CH, 12-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	4-CH	—	18	—	3.13 to 5.5	C, V, M, J	64 LQFP, 80 QFP, 112 LQFP, KGD	√
S12XS128	40 MHz	128 KB	8 KB	8 KB	—	—	—	√	—	1	2	1	—	16-CH, 12-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	4-CH	—	18	—	3.13 to 5.5	C, V, M, J	64 LQFP, 80 QFP, 112 LQFP, KGD	√
S12XS64	40 MHz	64 KB	4 KB	4 KB	—	—	—	√	—	1	2	1	—	16-CH, 12-bit	8-CH, 8-bit	—	—	—	8-CH, 16-bit	4-CH	—	18	—	3.13 to 5.5	C, V, M, J	64 LQFP, 80 QFP, 112 LQFP, KGD	√
S12XF512	50 MHz	512 KB	32 KB	—	4KB	√	—	√	√	1	2	2	—	16-CH, 12-bit	6-CH, 15-bit	—	—	—	8-CH, 16-bit	4-CH	—	11	—	3.13 to 5.5	C, V, M	112 LQFP, 64 LQFP	√
S12XF384	50 MHz	384 KB	24 KB	—	4KB	√	—	√	√	1	2	2	—	16-CH, 12-bit	6-CH, 15-bit	—	—	—	8-CH, 16-bit	4-CH	—	11	—	3.13 to 5.5	C, V, M	112 LQFP, 64 LQFP	√



S12 and S12X Families

Device	Bus Frequency	Flash	RAM	Data Flash	EEPROM	XGATE	MPU	ECC	FlexRay	CAN	SCI	SPI	I ² C	Analog (ADC)	PWM	Motor	SSD	ECT	Timer	PIT	LCD	KWU	EBI	Operating Voltage	Temp. Range ¹	Package Options	In Production
S12XF256	50 MHz	256 KB	20 KB	—	2 KB	√		√	√	1	2	2	—	16-CH, 12-bit	6-CH, 15-bit	—	—	—	8-CH, 16-bit	4-CH	—	11		3.13 to 5.5	C, V, M	112 LQFP, 64 LQFP	√
S12XF128	50 MHz	128 KB	16 KB	—	2 KB	√		√	√	1	2	2	—	16-CH, 12-bit	6-CH, 15-bit	—	—	—	8-CH, 16-bit	4-CH	—	11		3.13 to 5.5	C, V, M	112 LQFP, 64 LQFP	√
S12XHZ512	40 MHz	512 KB	32 KB	—	4 KB	√				2	2	1	2	16-CH, 10-bit	8-CH, 8-bit	24/6	6	8-CH, 16-bit	4-CH	32x4	8	√	4.5 to 5.5	C, V, M	112 LQFP, 144 LQFP	√	
S12XHZ384	40 MHz	384 KB	28 KB	—	4 KB	√				2	2	1	2	16-CH, 10-bit	8-CH, 8-bit	24/6	6	8-CH, 16-bit	4-CH	32x4	8	√	4.5 to 5.5	C, V, M	112 LQFP, 144 LQFP	√	
S12XHZ256	40 MHz	256 KB	16 KB	—	4 KB	√				2	2	1	2	16-CH, 10-bit	8-CH, 8-bit	24/6	6	8-CH, 16-bit	—	4-CH	32x4	8	√	4.5 to 5.5	C, V, M	112 LQFP, 144 LQFP	√
S12XHY256	40 MHz	256 KB	12 KB	8 KB	-	-	-	√	-	2	2	1	-	12-ch., 10-bit	8-CH, 8-bit/4-CH, 16-bit	16/4	4	-	-	16-CH., 16-bit	40 x 4	25	-	4.5 to 5.5	C, V, M	100 LQFP, 112 LQFP	
S12XHY128	40 MHz	128 KB	8KB	8 KB	-	-	-	√	-	2	2	1	-	12-ch., 10-bit	8-CH, 8-bit/4-CH, 16-bit	16/4	4	-	-	16-CH., 16-bit	40 x 4	25	-	4.5 to 5.5	C, V, M	100 LQFP, 112 LQFP	
S12P128	32 MHz	128 KB	6 KB	4 KB	—			√		1	1	1	—	10-CH, 12-bit	6-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	12		3.13 to 5.5	C, V, M	80 QFP, 64 LQFP, 48 QFN	√
S12P96	32 MHz	96 KB	6 KB	4 KB	—			√		1	1	1	—	10-CH, 12-bit	6-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	12		3.13 to 5.5	C, V, M	80 QFP, 64 LQFP, 48 QFN	√
S12P64	32 MHz	64 KB	4 KB	4 KB	—			√		1	1	1	—	10-CH, 12-bit	6-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	12		3.13 to 5.5	C, V, M	80 QFP, 64 LQFP, 48 QFN	√
S12P32	32 MHz	32 KB	2 KB	4 KB	—			√		1	1	1	—	10-CH, 12-bit	6-CH, 8-bit	—	—	—	8-CH, 16-bit	—	—	12		3.13 to 5.5	C, V, M	80 QFP, 64 LQFP, 48 QFN	√
S12HZ128	25 MHz	128 KB	6 KB	—	2 KB					2	2	1	1	16-CH, 10-bit	6-CH, 8-bit	16/4	4	—	8-CH, 8-bit	—	32x4	8		4.5 to 5.5	C, V, M	112 LQFP	√
S12HZ64	25 MHz	64 KB	4 KB	—	1 KB					1	1	1	—	8-CH, 10-bit	4-CH, 8-bit	16/4	4	—	8-CH, 8-bit	—	24x4	8		4.5 to 5.5	C, V, M	80 QFP, 112 LQFP	√
S12HN64	25 MHz	64 KB	4 KB	—	1 KB						1	1	—	8-CH, 10-bit	4-CH, 8-bit	16/4	4	—	8-CH, 8-bit	—	24x4	8		4.5 to 5.5	C, V, M	80 QFP, 112 LQFP	√
S12HY64	32 MHz	64 KB	4 KB	4 KB	—					1	1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√
S12HA64	32 MHz	64 KB	4 KB	4 KB	—						1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√
S12HY48	32 MHz	48 KB	4 KB	4 KB	—					1	1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√
S12HA48	32 MHz	48 KB	4 KB	4 KB	—						1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√
S12HY32	32 MHz	32 KB	2 KB	4 KB	—					1	1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√
S12HA32	32 MHz	32 KB	2 KB	4 KB	—						1	1	1	8-CH, 10-bit	8-CH, 8-bit	16/4	Support	—	8-CH+8-CH 16-bit	—	40x4	22		3.13 to 5.5	C, V, M	64 LQFP, 100 LQFP	√

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C

S12 MagniV Mixed-signal MCUs

Device	Bus Frequency	Flash	RAM	EEPROM	ECC	CAN	CAN-PHY	SCI	LIN-PHY	SPI	I ² C	Ext. Analog (ADC)	Int. Analog (ADC)	PWM	Timer	LCD	KWU	Motor	High Voltage Input	Other Analog	Vreg	Ext. Supply	Operating Voltage	Temp. Range ¹	Package Options	In Production
S12VR64	25 MHz	64 KB	2 KB	512 B	√	—	—	2	1	1	—	6-CH, 10-bit	4-CH, 10-bit	4-CH, 8-bit	4-CH, 16-bit	—	6	2-CH Relay, LS Driver	4-CH HVI, Vbat-Sense, Vsup Sense	2-CH, HS Driver	2	5 V, 20 mA	6.0 to 18	C, V	32 LQFP, 48 LQFP	√
S12VR48	25 MHz	48 KB	2 KB	512 B	√	—	—	2	1	1	—	6-CH, 10-bit	4-CH, 10-bit	4-CH, 8-bit	4-CH, 16-bit	—	6	2-CH Relay, LS Driver	4-CH HVI, Vbat-Sense, Vsup Sense	2-CH, HS Driver	2	5 V, 20 mA	6.0 to 18	C, V	32 LQFP, 48 LQFP	√
S12ZVH	32 MHz	128KB	8 KB	4 KB	√	1	1	2	—	1	1	8-CH, 10-bit	8-CH, 10-bit	8-CH(8-bit), 4-CH(16-bit)	Two 8-CH x16-bit	4x40	24	16/4	Vbat-Sense, Vsup Sense	—	2	5 V, 20 mA	5.5V to 18V	C, V	100 LQFP, 144 LQFP	
S12ZVHY	32 MHz	64 KB	4 KB	2 KB	√	—	—	2	—	1	1	4-CH, 10-bit	4-CH, 10-bit	8-CH(8-bit), 4-CH(16-bit)	Two 8-CH x16-bit	4x40	24	8/2	Vbat-Sense, Vsup Sense	—	1	5 V, 20 mA	5.5V to 18V	C, V	100 LQFP, 144 LQFP	
S12ZVFP	32 MHz	64 KB	4 KB	2 KB	√	—	—	2	1	1	1	4-CH, 10-bit	4-CH, 10-bit	8-CH(8-bit), 4-CH(16-bit)	Two 8-CH x16-bit	4x40	19	—	Vbat-Sense, Vsup Sense	—	1	5 V, 20 mA	5.5V to 18V	C, V	100 LQFP	
S12ZVML128	50 MHz	128 KB	8 KB	512 B	√	1	—	2	1	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	2	—	3.5V to 20V	V, M, W	64 LQFP-EP	
S12ZVMC128	50 MHz	128 KB	8 KB	512 B	√	1	—	2	—	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	2	—	3.5V to 20V	V, M, W	64 LQFP-EP	
S12ZVML64	51 MHz	64 KB	4 KB	512 B	√	1	—	2	1	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	1	—	3.5V to 20V	V, M, W	64 LQFP-EP	
S12ZVMC64	52 MHz	64 KB	4 KB	512 B	√	1	—	2	—	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	2	—	3.5V to 20V	V, M, W	64 LQFP-EP	
S12ZVML32	53 MHz	32 KB	2 KB	512 B	√	—	—	2	1	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	1	—	3.5V to 20V	V, M, W	64 LQFP-EP	
S12ZVM32	54 MHz	32 KB	2 KB	—	√	—	—	1	—	1	—	4+5-CH, 12-bit	8-CH, 12-bit	6-CH, 15-bit	4-CH, 16-bit	—	6	BLDC/ PMSM	Vsup-Sense	6-CH Gate Drive Unit	1	—	3.5V to 20V	V, M, W	64 LQFP-EP	

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°



DIGITAL SIGNAL CONTROLLERS

56800E Core—The 56800E MCU+DSP core was architected specifically to provide users the ease of use of an MCU together with the performance of a DSP in a single core.

56F8300 High-Performance Flash Series—The MC56F8300 series of controllers combines the 56800E core with flash memory, motor control peripherals, and built-in safety features targeted specifically for automotive applications to provide 60 MIPS of performance over the full -40°C to 125°C temperature range.

Memory—On-board memory includes program flash and RAM, data flash and RAM, and BootFlash with EEPROM emulation capability. The modified Harvard architecture enables users to perform up to three simultaneous memory accesses.

Service—A full-range of services is offered for the controller devices including software, support, training, and internal and third-party development tools.

For additional information, visit:

Documentation, Tool, and Product Libraries:
www.freescale.com

56F8xxx Family

Product	ROM (KB)	RAM	Flash	Timer	Serial	GPIO (pins)	A/D	PWM	Operating Voltage (V)	Operating Frequency (MHZ)	Temperature	Packaging	Additional Information
56F8013	0	4K	16K	4 x 16-bit	1 SCI/LIN + 1 SPI + 1 I ² C	26	1 x 4-CH 12-bit	1 x 6-CH	3.3	32	C, M	32-pin LQFP	mcPWM with center alignment, 1 x 4 channel Quad Decoder
56F8355	n/a	20K	280K	16 x 16-bit	2 SCI/LIN + 2 SPI + 1 CAN + 1 I ² C	49	4 x 4-CH 12-bit	2 x 6-CH	3.3	60	C, M	128-pin LQFP	mcPWM with center alignment, 2 x 4 channel Quad Decoder

QORIVVA 32-BIT MICROCONTROLLERS

Qorivva MPC56xx — Leveraging the success of the Qorivva MPC55xx family, Freescale has begun introducing the next generation (90nm) of 32-bit microcontrollers, which are built on Power Architecture™ technology: the family. The microcontrollers offer advanced features that help make cars safer and more fuel efficient while reducing harmful emissions. The Qorivva MPC56xx MCUs target a broad range of powertrain, safety, chassis, instrument cluster, body electronics and gateway applications.

The Qorivva MPC56xx family includes an array of package options for system performance needs and embedded Flash requirements. To assist in system development, the Qorivva MPC56xx family offers support including application software, development tools, training, documentation and technical support.

The Qorivva MPC56xx portfolio will continue to grow with devices that offer expanded sets of memory, connectivity and performance options.

For additional information, visit:

Documentation, Tool, and Product Libraries
www.freescale.com

Automotive Home Page
www.freescale.com/automotive

Qorivva homepage
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Qorivva MPC56xx Family

Device	Core Platform	Bus Frequency	Program Flash	SRAM	DMA	EEPROM	MPU/MMU	CTU	SCI (LINFlex)	DSPI	CAN	I ² C	FlexRay™	Ethernet (100BaseT)	MLB	eTPU	eMIOS	Motor Control Timers	PIT	Analog (ADC)	Operating Voltage	Temp. Range ¹	Debug	Package Options	In Production
MPC5744P	2 x e200z4	180 MHz	2.5 MB	384 KB	32-CH	Emulated in Program Flash	32 Entry	2	2	4	3	√						(3 x 6-ch., E-Timer), (2 x 12-ch, PWM)	4-CH	Quad, 25-ch. External, 12-bit	3.3	C, V, M	Nexus 3+, MDO and Aurora interface	144 LQFP, 257 MAPBGA	
MPC5746R	3 x e200z4	3 x 200 MHz	4 MB	320 KB	64-CH	288 KB	MPU		6	7	4	√	√			64-CH	32-CH		8	4 x SAR, 3 x SD	3.3, 5	M	Nexus 3+, JTAG	176 LQFP-EP, 252 MAPBGA	
MPC5746M	4 x e200z4	4 x 200 MHz	4 MB	320 KB	64-CH	288 KB	Yes, No		5	7	3/1	1	√	√		120-CH				8 x SAR, 6 x SD	3.3, 5	M	Nexus 3+, Zipwire Aurora, JTAG	176 LQFP-EP, 292 MAPBGA	
MPC5746G	Dual e200z7	2x180 MHz	6 MB	384 KB	96-CH	64 KB Data Flash	32 entry	√	3	10	8	4	√	√					16	Up to 32-CH, 12-bit, 48-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	176 LQFP, 256 MAPBGA, 324 MAPBGA	
MPC5747C	e200x4, e200x2	180 MHz, 80 MHz	4 MB	512 KB	32-CH	Emulated	24-CH MPU	√	Up to 16	10	8	4	√	√					16	Up to 32-CH, 12-bit, 48-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	176 LQFP, 256 MAPBGA, 324 MAPBGA	
MPC5747G	Dual e200x4, e200x2	180 MHz, 80 MH	4 MB	768 KB	32-CH	Emulated	32-CH MPU	√	Up to 18	10	8	4	√	√	√				16	Up to 32-CH, 12-bit, 48-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	176 LQFP, 256 MAPBGA, 324 MAPBGA	
MPC5748C	e200x4, e200x2	180 MHz, 80 MH	6 MB	768 KB	32-CH	Emulated	24-CH MPU	√	Upto 16	10	8	4	√	√					16	Up to 32-CH, 12-bit, 48-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	176 LQFP, 256 MAPBGA, 324 MAPBGA	
MPC5748G	Dual e200x4, e200x2	180 MHz, 80 MH	6 MB	768 KB	32-CH	Emulated	32-CH MPU		Up to 18	10	8	4	√	√	√				16	Up to 32-CH, 12-bit, 48-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	176 LQFP, 256 MAPBGA, 324 MAPBGA	



Qorivva MPC56xx Family

Device	Core Platform	Bus Frequency	Program Flash	SRAM	DMA	EEPROM	MPU/MMU	CTU	SCI (LINFlex)	DSPI	CAN	µC	FlexRay™	Ethernet (100BaseT)	MLB	eTPU	eMIOS	Motor Control Timers	PIT	Analog (ADC)	Operating Voltage	Temp. Range ¹	Debug	Package Options	In Production	
MPC5777M	3 x e200z7 + 1 x e200z4	3 x 300 MHz + 1 x 200MHz	8 MB	596 KB	128-CH	8 x 64 KB	Yes, No		6	8	4/1	2	√	√		248-CH				12 x SAR, 10 x SD	3.3, 5	M	Nexus 3+, Zipwire Aurora, JTAG	416 PBGA, 512 PBGA		
MPC5676R	Dual e200z7	2x180 MHz	6 MB	384 KB	96-CH	64 KB Data Flash	32 entry		3	5	4		√			96-CH	Up to 32-CH, 16-bit			Up to 64-CH, 12-bit 12 xDEC Filters	3.3V, 5V	M	Nexus 3+	416 BGA, 516 BGA		
MPC5674F	e200z7	150, 200, 264 MHz	4 MB	256 KB	64-CH + 32-CH	Emulated in Program Flash	0	√	3	4 (MSB)	4		√			2x32-CH	32-CH			Quad 64-CH	3.3V, 5V	M	Nexus 3+	324 BGA, 416 BGA, 516 BGA	√	
MPC5673F	e200z7	150, 200, 264 MHz	3 MB	192 KB	64-CH + 32-CH	Emulated in Program Flash	0	√	3	4 (MSB)	4		√			2x32-CH	32-CH			Quad 64-CH	3.3V, 5V	M	Nexus 3+	324 BGA, 416 BGA, 516 BGA	√	
MPC5673K	Dual e200z7	2x180 MHz	1 MB	256 KB	2x 32-CH	64 KB	µεσ	2	3	2	4	2	√	√				3 x PWM; 3 x ETIMER	1	4 x 12-bit, 34-CH	3.3V, 1.2V	C, V, M	Nexus 3+	257 MAPBGA, 473 MAPBGA	√	
MPC5675K	Dual e200z7d	45 MHz	2 MB	512 KB	32-CH	Emulated in Program Flash	64 entry	2	4	3	4	3	opt.	√					4-CH	4-CH, 12-bit	3.3V, 5V	M, V	Nexus 3+	473 MAPBGA, 275 MAPBGA	√	
MPC5674K	Dual e200z7d	180 MHz	1.5 MB	384 KB	2 x 32-CH	64KB	√	2	4	3	4	3	√	√				3 x PWM; 3 x ETIMER	4-CH	4 x 12-bit, 34-CH	3.3V, 5V	C, V, M	Nexus 3+	257 MAPBGA, 473 MAPBGA	√	
MPC5668G	e200z6 + e200z0	128 MHz	2 MB	592KB	16-CH	64 KB			6	4	6	4	√	√	√		16-CH, 24-bit		8-CH	36-CH, 10-bit	3.3V, 5V	V	Nexus3 on z6 and Nexus 2+	208 MAPBGA	√	
MPC5668E	e200z0 + e200z0	116 MHz	2 MB	128 KB	32-CH	Emulated in Program Flash	16 entry	√	12	4	5	4					32-CH, 16-bit		8-CH	64-CH, 10-bit	3.3V, 5V	V, M	JTAG, Nexus3 onz6 and Nexus2+	208 MAPBGA, 256 MAPBGA only for devt.	√	
MPC5604E	e200z0h	64 MHz	512 KB	96 KB	16-CH	64 KB	yes		2	3	1	3		√					1 x E-Timer	1	8-CH, 10-bit	3.0V, 1.2V	C, V, M	Nexus 2+	64 LQFP	
MPC5634M	e200z3	60, 80 MHz	1.5M	94 KB	32-CH	Emulated in Program Flash	8 Entry		2	2	2	0				32-CH	16-CH, 24-bit		5-CH	Dual 34-CH, 12-bit	5V	M	Nexus 2+ Wide trace port in Vertical Calibration System	144 LQFP, 176 LQFP, 208 MAPBGA	√	
MPC5633M	e200z3	40, 60, 80 MHz	1M	64 KB	32-CH	Emulated in Program Flash	8 Entry		2	2	2	0				32-CH	16-CH, 24-bit		5-CH	Dual 34-CH, 12-bit	5V	M	Nexus 2+ Wide trace port in Vertical Calibration System	100 LQFP, 144 LQFP, 176 LQFP, 208 MAPBGA	√	
MPC5632M	e200z3	40, 60 MHz	768 KB	48 KB	32-CH	Emulated in Program Flash	8 Entry		2	2	2	0				32-CH	8-CH, 24-bit		5-CH	Dual 32-CH, 12-bit	5V	M	Nexus 2+ Wide trace port in Vertical Calibration System	100 LQFP, 144 LQFP	√	
MPC5643L	e200z4x2	80/120 MHz	1 MB	128 KB	16-CH	64 KB Data Flash	16 Entry	√	2	3	2	0	√					46-Ch. eTimer/PWM/STM	4-Ch.	Dual 16-Ch., 12-bit	3.3V	M	Nexus 3+	144 LQFP, 257 MAPBGA	√	
MPC5646C	e200z4 + e200z0	120 MHz, 60 MHz	3 MB	256 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√	√			64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5646B	e200z4	120 MHz	3 MB	192 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√				64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5645C	e200z4 + e200z0	120 MHz, 60 MHz	2 MB	256 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√	√			64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5645B	e200z4	120 MHz	2 MB	160 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√				64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5644C	e200z4 + e200z0	120 MHz, 60 MHz	1.5 MB	192 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√	√			64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5644B	e200z4	120 MHz	1.5 MB	128 KB	16-CH	64 KB Data Flash	16 Entry	√	10	8	6	1	√				64-CH, 16-bit		Up to 8-CH	Up to 29-CH, 12-bit, Up to 33-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 3+	256 BGA, 208 LQFP, 176 LQFP	√	
MPC5607B	e200z0	64 MHz	1.5 MB	96 KB	16-CH	64 KB Data Flash	8 Entry	√	Up to 10	6	6	1					64-CH, 16-bit			16-CH, 10/12-bit & up to 32-Ch., 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208MAPBGA Emul. Only Package) JTAG	176 LQFP	√	



Qorivva MPC56xx Family

Device	Core Platform	Bus Frequency	Program Flash	SRAM	DMA	EEPROM	MPU/MMU	CTU	SCI (LINFlex)	DSPI	CAN	ƒ _C	FlexRay™	Ethernet (100BaseT)	MLB	eTPU	eMIOS	Motor Control Timers	PIT	Analog (ADC)	Operating Voltage	Temp. Range ¹	Debug	Package Options	In Production	
MPC5606B	e200z0	64 MHz	1 MB	80KB	16-CH	64 KB Data Flash	8 Entry	√	Up to 8	Up to 6	6	1					64-CH, 16-bit			16-CH, 10/12-bit & up to 32-Ch., 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208MAPBGA Emul. Only Package) JTAG	144 LQFP, 176 LQFP	√	
MPC5605B	e200z0	64 MHz	768 KB	64KB	16-CH	64 KB Data Flash	8 Entry	√	Up to 8	Up to 6	6	1					64-CH, 16-bit			16-CH, 10/12-bit & up to 32-Ch., 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208MAPBGA Emul. Only Package) JTAG	100 LQFP, 144 LQFP, 176 LQFP	√	
MPC5604B	e200z0	64 MHz	512 KB	32KB		64 KB Data Flash	8 Entry	√	4	3	3	1					56-CH, 16-bit	up to 6-CH	up to 36-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208MAPBGA Emul. Only Package) JTAG	100 LQFP, 144 LQFP	√		
MPC5603B	e200z0	64 MHz	384 KB	28KB		64 KB Data Flash	8 Entry	√	4	3	3	1					56-CH, 16-bit	up to 6-CH	up to 36-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208 MAPBGA Emul. Only Package) JTAG	100 LQFP, 144 LQFP	√		
MPC5602B	e200z0	64 MHz	256 KB	24KB		64 KB Data Flash	8 Entry	√	3	3	2	1					56-CH, 16-bit	up to 6-CH	up to 36-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208 MAPBGA Emul. Only Package) JTAG	100 LQFP, 144 LQFP	√		
MPC5604C	e200z0	64 MHz	512 KB	48 KB		64 KB Data Flash	8 Entry	√	4	3	6	1					28-CH, 16-bit		3-CH	28-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208 MAPBGA Emul. Only Package) JTAG	100 LQFP	√	
MPC5603C	e200z0	64 MHz	384 KB	40 KB		64 KB Data Flash	8 Entry	√	4	3	6	1					28-CH, 16-bit		3-CH	28-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208 MAPBGA Emul. Only Package) JTAG	100 LQFP	√	
MPC5602C	e200z0	64 MHz	256 KB	32 KB		64 KB Data Flash	8 Entry	√	4	3	6	1					28-CH, 16-bit		3-CH	28-CH, 10-bit	3.3V, 5V	C, V, M	Nexus 2+ (208 MAPBGA Emul. Only Package) JTAG	100 LQFP	√	
MPC5601D	e200z0	48 MHz	128 KB	12 KB	16-CH	64 KB Data Flash		√	3	2	1						Up to 28-CH, 16-bit	Up to 4-CH	Up to 33-CH, 12-bit	3.3V, 5V	C, V, M	JTAG	100 LQFP, 64 LQFP	√		
MPC5602D	e200z0	48 MHz	256 KB	16 KB	16-CH	64 KB Data Flash		√	3	2	1						Up to 28-CH, 16-bit	Up to 4-CH	Up to 33-CH, 12-bit	3.3V, 5V	C, V, M	JTAG	100 LQFP, 64 LQFP	√		
MPC5604P	e200z0	40/64 MHz	512 KB	40 KB	16-CH	64 KB Data Flash		√	2	4	2	0	√					20-CH eTimer/PWM	4-CH	Dual 13-CH, 10-bit	3.3V, 5V	M	Nexus 2+	100 LQFP, 144 LQFP	√	
MPC5603P	e200z0	40/64 MHz	384 KB	36 KB	16-CH	64 KB Data Flash		√	2	4	2	0	√					20-CH eTimer/PWM	4-CH	Dual 13-CH, 10-bit	3.3V, 5V	M	Nexus 2+	100 LQFP, 144 LQFP	√	
MPC5602P	e200z0	40/64 MHz	256 KB	20 KB	16-CH	64 KB Data Flash		√	2	3	2	0						14-CH eTimer/PWM	4-CH	16-CH, 10-bit	3.3V, 5V	M	Nexus 1 (Emulation with MPC5604P)	64 LQFP, 100 LQFP	√	
MPC5601P	e200z0	40/64 MHz	192 KB	12 KB	16-CH	64 KB Data Flash			1	1	1	0						6-CH eTimer	4-CH	11-CH, 10-bit	3.3V, 5V	M	Nexus 1 (Emulation with MPC5604P)	64 LQFP, 100 LQFP	√	
MPC5644A	e200z4	120, 132, 150 MHz	4 MB	192 KB	64-CH	Emulated in Program Flash	24 entry MMU		3	3(MSB)	3		√				32-CH	24-bit		5-CH	Dual 40-CH, + 2 DECFIL	3.3V, 5V	M	Nexus3+ Vertical Calibration system	176 QFP, 208MAPBGA, 324 MAPBGA	√
MPC5643A	e200z4	120, 132, 150 MHz	3 MB	192 KB	64-CH	Emulated in Program Flash	24 entry MMU		3	3(MSB)	3		√				32-CH	24-bit		5-CH	Dual 40-CH, + 2 DECFIL	3.3V, 5V	M	Nexus3+ Vertical Calibration system	176 QFP, 208MAPBGA, 324 MAPBGA	√
MPC5642A	e200z4	120, 132, 150 MHz	2 MB	192 KB	64-CH	Emulated in Program Flash	24 entry MMU		3	3(MSB)	3		√				32-CH	24-bit		5-CH	Dual 40-CH, + 2 DECFIL	3.3V, 5V	M	Nexus3+ Vertical Calibration system	176 QFP, 208MAPBGA, 324 MAPBGA	√

Device	Core Platform	Bus Frequency	Program Flash	SRAM	eDMA	Emulated EEPROM	TFT Drive	Stepper Drive	SCI (LINFlex)	DSPI	CAN	ƒ _C	LCD	Sound Generator	Memory Expansion	MPU	eMIOS	Timers	Analog (ADC)	Operating Voltage	Temp. Range ¹	Debug	Package Options	In Production	
MPC5645S	e200z4d	125 MHz	2 MB	64 KB	16-CH	4 x 16 KB	Up to 2 Display Control Unit (DCU) with Parallel Data Interface (PDI)	Up to 6 gauges w/ Stepper Stall Detect (SSD)	Up to 6	Up to 3	3	4		√	Quad SPI	16 Entry			RTC, API, 8-ch, 32-bit PIT and S/W Watchdog Timer	Up to 20-CH, 10-bit	3.3V and 5V	C, V	Nexus 3+	176 LQFP, 208 LQFP, 416 TEPBGA	
MPC5606S	e200z0h	64 MHz	1 MB	48 KB + 160 KB Graphics RAM	16-CH	4x16 KB	Display Control Unit (DCU) with Parallel Data Interface (PDI)	6 gauges w/Stepper Stall Detect (SSD)	2	3	2	4	40x4	Yes (using eMIOS)	QuadSPI	12 entry	2-CH	Real Time Counter (RTC), Autonomous Periodic Interrupt (API), 4-CH 32-bit PIT and S/W watchdog timer.	16-CH, 10-bit	3.3V and 5V	C, V, M	Nexus 2+	144 LQFP, 176 LQFP	√	
MPC5604S	e200z0h	64 MHz	512 KB	48 KB	16-CH	4x16 KB	No	6 gauges w/Stepper Stall Detect (SSD)	2	2	2	2	64x6	√		12 entry	2-CH	Real Time Counter (RTC), Autonomous Periodic Interrupt (API), 4-CH 32-bit PIT and S/W watchdog timer.	16-CH, 10-bit	3.3V and 5V	C, V, M	Nexus 1	100 LQFP, 144 LQFP		
MPC5602S	e200z0h	64 MHz	256 KB	24 KB	16-CH	4x16 KB	No	6 gauges w/Stepper Stall Detect (SSD)	2	3	1	2	64x6	√		12 entry	2-CH	Real Time Counter (RTC), Autonomous Periodic Interrupt (API), 4-CH 32-bit PIT and S/W watchdog timer.	16-CH, 10-bit	3.3V and 5V	C, V, M	Nexus 1	100 LQFP, 144 LQFP		

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C

Image Cognition Processors

Device	Primary Core Platform	Core Frequency	Secondary Core Platform	SRAM	DMA	Video Accelerator	Graphics Accelerator	Image Processor	Camera Input	Display Interface	DRAM Support	Flash Support	USB 2.0	PCI express	I2S	I ² C	SPI	UART	Timers	ADC	PIT	3.3 V GPIO	Voltage	Temp. Range ¹	Package Options	In Production
SPC2201	ARM926	350 MHz	APEX - SMD Array, Slave ARM926	16 MB DRAM					PDI	LCD/WVGA		NAND, Serial NOR flash	HS OTG + HS Phy		1	2	1	4				√	1	C	236 BGA	
SPC2207	ARM926	350 MHz	APEX - SMD Array, Slave ARM926	64 MB DRAM					PDI	LCD/WVGA		NAND, Serial NOR flash	HS OTG + HS Phy		1	2	1	4				√	1	C	236 BGA	

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°

Qorivva MPC55xx — Based on Power Architecture™ technology and system-on-chip (SoC) design, Qorivva MPC55xx microcontrollers offer advanced features that help make cars safer and more fuel efficient, while reducing harmful emissions. The Qorivva MPC55xx MCUs target a broad range of automotive applications, including powertrain control, advanced safety, driver assistance, chassis and body electronics.

The MPC55xx family includes an array of package options for systems performance needs and embedded flash requirements. Offering pin-compatibility throughout the entire flash-based family, engineers are given the ability to migrate their efforts from one design to another.

another, reducing development costs and improving time to market. To assist in development, the Qorivva MPC55xx family offers support including application software, development tools, training, documentation and technical support.

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Qorivva MPC55xx Family

Device	Core Platform	Bus Frequency	Program Flash	SRAM	DMA	EEPROM	eSCI	DSPI	CAN	I ² C	Flexray	Ethernet (100BaseT)	MLB	External Bus	Debug	eTPU	eMIOS	PIT	Analog (ADC)	Operating Voltage	Temp. Range ¹	Package Options	In Production
MPC5534	e200z3	40, 66, 80 MHz	1 MB	64 KB	32-CH	Emulated in program Flash	2	3	2					√	Nexus 3	32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	M	208 MAPBGA, 324 PBGA	√
MPC5553	e200z6	80, 112, 132 MHz	1.5 MB	64 KB	32-CH	Emulated in program Flash	2	3	2			√		√	Nexus 3	32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	M	208 MAPBGA, 324 PBGA, 416 PBGA	√
MPC5554	e200z6	80, 112, 132 MHz	2 MB	64 KB	64-CH	Emulated in program Flash	2	4	3					√	Nexus 3	2x32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	M	416 PBGA	√
MPC5561	e200z6	80, 112, 132 MHz	1 MB	192 KB	32-CH	Emulated in program Flash	4	2	2		√			√	Nexus 3		24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	C, M	324 PBGA	√
MPC5565	e200z6	80, 112, 132 MHz	2 MB	80 KB	32-CH	Emulated in program Flash	2	3	3					√	Nexus 3	32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	M	324 PBGA	√
MPC5566	e200z6	80, 112, 132, 144 MHz	3 MB	128 KB	64-CH	Emulated in program Flash	2	4	4			√		√	Nexus 3	2x32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	C, M	416 PBGA	√
MPC5567	e200z6	80, 112, 132 MHz	2MB	80 KB	32-CH	Emulated in program Flash	2	3	5		√	√	emulated via eTPU	√	Nexus 3	32-CH, 24-CH, 24-bit	24-CH, 24-bit		40-CH, 12-bit	3.3V and 5V	C, M	324 PBGA, 416 PBGA	√

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C.
 Note: specs given are for the largest package size stated.



MPC52xx and MPC51xx Families

Device	Core Platform	Bus Frequency	Cache	Audio Acceleration	DRAM Bandwidth	Bus System	Graphics Acceleration	Display Controller	Memory Interface	External Memory Bus	PSC	i ² C	CAN	USB 2.0	Secure Digital	Ethernet (100 BaseT)	Temp ¹	Package	In Production
MPC5200B	e300	400 MHz, 760 MIPS	16K I/D	None	300 MBs	Single port	None	None	16/32-bit DDR-I	NOR Flash	6	2	2	2 (USB 1.1)		√	C	272 TE-PBGA	√
MPC5121e	e300	400 MHz, 800 MIPS	32K I/D	AXE, 200 MHz, 32-bit RISC	1100 MBs	5-port 64-bit @200MHz	OpenGL-ES 1.1 OpenVG 1.0	1280x720 24-bit 3-plane blend	16/32-bit DDR-I/II & MobileDDR-I Controller	8/16-bit NAND Flash controller	12	3	4	2	MMC SD SDIO	√	C	516 PBGA	√

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C



i.MX 32-BIT APPLICATIONS PROCESSORS

The AEC-Q100 automotive-qualified i.MX applications processors are based on ARM9 and ARM11 CPU cores coupled with a wide range of connectivity peripherals and hardware accelerators. Target automotive applications include infotainment, navigation, hands-free calling, telematics and fully configurable Instrumentation clusters.

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i.MX Applications Processors

Device	Core Platform	CPU Frequency	Cache	SRAM	DMA	Video Accelerator	Graphics Accelerator	Image Processor	Camera Input	Display Interface	DRAM Support	Flash Support	USB (2.0)	CAN	MLB	SD/MMC SDIO	I ² C	SPI	UART	Ethernet (100BaseT)	HDD Interface	SSI/I2S	Sample Rate Converter	SP DIF I/O	PIT	3.3V GPIO	Voltage	Temp. Range ¹	Package Options	In Production
i.MX285	ARM926	454 MHz	L1: 16 KB/32 KB I/D	128 KB	32-Ch.					TFT up to WVGA	mDDR, DDR2	SLC NAND, MLC NAND, QSPI Flash	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2		x3	x2	x3	x6	10/100 x1 GMII or x2 RMII with IEEE 1588	ATA-6	x3		1x	8	√	Internally Generated	C	289 MAPBGA	√
i.MX281	ARM926	454 MHz	L1: 16 KB/132B I/D	128 KB	32-Ch.						mDDR, DDR2	SLC NAND, MLC NAND, QSPI Flash	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2		x3	x2	x3	x6	10/100 x1 GMII or x2 RMII with IEEE 1588	ATA-6	x3		1x	8	√	1.38V to 1.52V	C	289 MAPBGA	√
i.MX251	ARM926	400 MHz	L1: 16 KB/16 KB I/D	128 KB	32-Ch.						SDRAM mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2		2	3	3	5	√	ATA-6	2			4	√	1.38V to 1.52V	C	400 MAPBGA	√
i.MX255	ARM926	400 MHz	L1: 16 KB/16 KB I/D	128 KB	32-Ch.				CCIR656	TFT up to 800x600	SDRAM mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2		2	3	3	5	√	ATA-6	2			4	√	1.38V to 1.52V	C	400 MAPBGA	√
i.MX351	ARM1136 w/Vector Floating Point	532 MHz	L1: 16 KB/16 KB I/D L2: 128 KB Unified	128 KB	32-Ch.						SDRAM mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2	√	3	3	2	3	√	ATA-6	2+ES AI	Yes, Async.	Yes	3	√	1.22V to 1.47V	C	400 MAPBGA	√
i.MX355	ARM1136 w/Vector Floating Point	532 MHz	L1: 16 KB/16 KB I/D L2: 128 KB Unified	128 KB	32-Ch.			√	CCIR656	TFT up to 800x600	SDRAM mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2	√	3	3	2	3	√	ATA-6	2+ES AI	Yes, Async.	Yes	3	√	1.22V to 1.47V	C	400 MAPBGA	√
i.MX356	ARM1136 w/Vector Floating Point	532 MHz	L1: 16 KB/16 KB I/D L2: 128 KB Unified	128 KB	32-Ch.		OpenVG 1.1	√	CCIR656	TFT up to 800x600	SDRAM mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy HS Host+FS Phy or ext. HS Phy	2	√	3	3	2	3	√	ATA-6	2+ES AI	Yes, Async.	Yes	3	√	1.22V to 1.47V	C	400 MAPBGA	√
i.MX514	ARM Cortex A8 with VPU and NEON	600 MHz	L1: 32KB/32KB I/D L2: 256KB Unified	96 KB	32 Ch		OpenVG 1.1; OpenGL ES2.0	√	CCIR656	WXGA; Dual TFT	mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy and 3x HS Host			4	3	2	3	√	ATA-6	3		Yes (Tx)	3	√	0.95V to 1.10V	C	529 MAPBGA	√
i.MX516	ARM Cortex A8 with VPU and NEON	600 MHz	L1: 32KB/32KB I/D L2: 256KB Unified	96 KB	32 Ch.	D1 encode; HD720 decode	OpenVG 1.1; OpenGL ES2.0	√	CCIR656	WXGA; Dual TFT	mDDR, DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy and 3x HS Host			4	3	2	3	√	ATA-6	3		Yes (Tx)	3	√	0.95V to 1.10V	C	529 MAPBGA	√
i.MX534	ARM Cortex A8 with VPU and NEON	800 MHz	L1: 32KB/32KB I/D L2: 256KB Unified	128 KB	32 Ch.		OpenVG 1.1; OpenGL ES2.0	√	CCIR656	UXGA; Dual TFT	DDR2, DDR3, LP-DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy and HS Host+FS Phy and 2x HS Host	2	25/50	4	3	3	5	10/100 with IEEE 1588	SATA, PATA	3+ ESAI	Yes, Asynchronous	Yes	3	√	0.95V to 1.10V	C	529 MAPBGA	√
i.MX536	ARM Cortex A8 with VPU and NEON	800 MHz	L1: 32KB/32KB I/D L2: 256KB Unified	128 KB	32 Ch	HD720 encode; HD1080 decode	OpenVG 1.1; OpenGL ES2.0	√	CCIR656	UXGA; Dual TFT	DDR2, DDR3, LP-DDR2	NOR, SLC NAND MLC NAND	HS OTG+HS Phy and HS Host+FS Phy and 2x HS Host	2	25/50	4	3	3	5	10/100 with IEEE 1588	SATA, PATA	3+ ESAI	Yes, Asynchronous	Yes	3	√	0.95V to 1.10V	C	529 MAPBGA	√
i.MX6D4	Dual ARM Cortex A9	852 MHz, 1 GHz	L1: 32KB/32KB I/D L2: 512KB Unified	256 KB	32 Ch		OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	√	CCIR656	Up to 4xWXGA	x64 DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	5	5	1 GB with IEEE 1588	SATA	3+ ESAI	Yes, Asynchronous	Yes	3	√	1.275V to 1.50V	C	625 Flip Chip BGA	√



i.MX Applications Processors cont.

Device	Core Platform	CPU Frequency	Cache	SRAM	DMA	Video Accelerator	Graphics Accelerator	Image Processor	Camera Input	Display Interface	DRAM Support	Flash Support	USB (2.0)	CAN	MLB	SD/ MMC SDIO	i ² C	SPI	UART	Ethernet (100BaseT)	HDD Interface	SS/ I2S	Sample Rate Converter	SP DIF I/O	PIT	3.3V GPIO	Voltage	Temp. Range ²	Package Options	In Production
i.MX6D6	Dual ARM Cortex A9	852 MHz, 1 GHz	L1: 32KB/32KB I/D L2: 512KB Unified	256 KB	32 Ch	Multi-Format 1080p Encode and Decode	OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 4xWXGA	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	5	5	1 GB with IEEE 1588	SATA	3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 Flip Chip BGA	✓
i.MX6Q4	Quad ARM Cortex A9	852 MHz, 1 GHz	L1: 32KB/32KB I/D L2: 512KB Unified	256 KB	32 Ch		OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 4xWXGA	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	3	5	1 GB with IEEE 1588	SATA	3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 Flip Chip BGA	✓
i.MX6Q6	Quad ARM Cortex A9	852 MHz, 1 GHz	L1: 32KB/32KB I/D L2: 512KB Unified	256 KB	32 Ch	Multi-Format 1080p Encode and Decode	OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 4xWXGA	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	5	5	1 GB with IEEE 1588	SATA	3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 Flip Chip BGA	✓
i.MX6S1	ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch						x32 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓
i.MX6S4	ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch		OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 2xWXGA	x32 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓
i.MX6S6	ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch	Multi-Format 1080p Encode and Decode	OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 2xWXGA	x32 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓
i.MX6U1	Dual ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch					UXGA; Dual TFT	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓
i.MX6U4	Dual ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch		OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition		MIPI, CCIR656	Up to 2xWXGA	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓
i.MX6U6	Dual ARM Cortex A9	800 MHz	L1: 32KB/32KB I/D L2: 512KB Unified	128 KB	32 Ch	HD720 encode; HD1080 decode	OpenVG 1.1; (3D Core) OpenGL ES2.0, 3.0 Display Composition	✓	MIPI, CCIR656	Up to 2xWXGA	x64 DDR3, LV-DDR3, LP-DDR2	x16 NOR, x8 SLC/MLC NAND	HS OTG+HS Phy, HS Host+HS Phy, x2 HSIC	2	25/50/150	4	4	4	5	1 GB with IEEE 1588		3+ ESAI	Yes, Asynchronous	Yes	3	✓	1.275V to 1.50V	C	625 MAPBGA	✓

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C
 2. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C

32-bit Vybrid Controller Solutions

Device	Core Platform	CPU Frequency	Cache	SRAM	DMA	Video Accelerator	Graphics Accelerator	Image Processor	Camera Input	Display Interface	DRAM Support	Flash Support	USB (2.0)	CAN	MLB	SD/ MMC SDIO	i ² C	SPI	UART	Ethernet (100BaseT)	HDD Interface	I2S	Sample Rate Converter	SP DIF I/O	PIT	3.3V GPIO	Voltage	Temp. Range ¹	Package Options	In Production
Vybrid SVFxxxR	ARM® Cortex®-A5/M4	400 MHz	L1: 32 KB/ 32 KB I/D L2: 512 KB Up to 1.5 MB	Up to 1.5 MB	✓		OpenVG 1.1		18-bit Composite (4 to 1) + VADC	2 (Up to WVGA) + Segment Display (40 x 4)	DDR3 LP-DDR2	Dual Quad SPI, NAND, FlexBus	2x USB OTG HS + Phy	50	✓	2	4	4	6	2x 10/100		4x SAIFx ESAI	yes	yes		3.0 V to 3.6 V	C	176 LQFP 364 BGA	✓	

1. C = -40°C to +85°C, V = -40°C to +105°C, M = -40°C to +125°C, J = -40°C to +140°C, W = -40°C to +150°C

— Definitions —

ADC — Analog-to-Digital Converter
 ASK — Amplitude Shift Keying Modulation
 BDM — Background Debug Mode
 CAN — Controller Area Network
 CDIP — Ceramic Dual In-Line Package
 CLCC — Ceramic Leaded Chip Carrier
 COP — Computer Operating Properly (Watchdog Timer)
 CPU16 — 16-bit Central Processor Unit (HC11 Compatible)
 CPU32 — 32-bit Central Processor Unit (68000 Compatible)
 CTM — Configurable Timer Module (Various Hardware Options)
 DAB — Digital Audio Broadcasting
 DIP — Dual In-line Package
 DSPI — Deserial Peripheral Interface
 EBI — External Bus Interface
 ECT — Enhanced Capture Timer
 eDMA — Enhanced Direct Memory Access Controller
 eTPU — Enhanced Timing Processor Unit
 eMIOS — Enhanced Modular Input Output System
 eQADC — Enhanced Queued Analog-to-Digital Converter
 eSCI — Enhanced Serial Communications Interface
 FSK — Frequency Shift Keying Modulation
 GPT — General-Purpose Timer Module (4 IC, 5 OC, 2 PWM)
 HQFP — Heatsink Quad Flat Package
 HSOP — Heatsink Small Outline Package
 i — Input-Only Port Pins
 i/o — Bidirectional Input and Output Port Pins
 I²C — Inter-Integrated Circuit
 IC — Input Capture
 ISPI — Interval Serial Peripheral Interface
 LQFP — Low-Profile Quad Flat Package (1.4mm thick)
 LVI — Low-Voltage Interrupt
 LVR — Low-Voltage Reset
 MCCI — Multi-Channel Communication Interface (2 SCI, SPI)
 MFT — Multi-Function Timer
 MUX — Multiplexed
 OC — Output Compare
 OOK — On-Off Keying
 PBGA — Plastic Ball Grid Array
 PDIP — Plastic Dual In-Line Package
 PEEP — Personality EEPROM
 PEP — Personality EPROM
 PLCC — Plastic Leaded Chip Carrier
 PLL — Phase-Locked Loop
 PQFP — Plastic Quad Flat Pack
 PWM — Pulse-Width Modulation
 QADC — Queued Analog-to-Digital Converter (10-bit)
 PQFN — Quad Flat No-Lead Package
 QFN — Quad Flat No-Lead Package

QFP — Quad Flat Package
 QSM — Queued Serial Module (SCI + QSPI)
 QSPI — Queued SPI
 RTI — Real-Time Interrupt
 SCI — Serial Communication Interface
 SCIE — Enhanced SCI
 SCIM — Single-Chip Integration Module
 SDIP — Shrink Dual In-line Package
 SIM — System Integration Module
 SIML — Low-Power System Integration Module
 SIOP — Simple Serial I/O Port
 SOICN — Small Outline Package Narrow Body
 SOICW — Small Outline Package Wide Body
 SPI — Serial Peripheral Interface
 ESPI — Enhanced SPI
 SRAM — Standby RAM Module
 SSOP — Shrink Small Outline Package
 TPU — Time Processor Unit (16 Programmable Channels)
 TPURAM — Standby RAM Module with TPU Emulation Capability
 TQFP — Thin Quad Flat Package (1.0mm thick)
 TSSOP — Thin Shrink Small Outline Package
 UART — Universal Asynchronous Receiver/Transmitter
 UDFN — Ultra-thin dual flat no-lead package
 USB — Universal Serial Bus

— Package Designators —

B — Shrink DIP (70 mil spacing)
 DW — Small Outline (Wide-Body SOIC)
 DWB — Small Outline (Wide body SDIB) 0.65 pitch
 FA — 7 x 7 mm Quad Flat Pack (QFP)
 FB — 10 x 10 mm Quad Flat Pack (QFP)
 FC — QFN Quad Flat Pack
 FE — CQFP (windowed) — Samples Only
 FN — Plastic Quad (PLCC)
 FS — CLCC (windowed) — Samples Only
 FT — 28 x 28 mm Quad Flat Pack (QFP)
 FU — 14 x 14 mm Quad Flat Pack (QFP)
 FZ — CQFP (windowed) — Samples Only
 K — Cerdip (windowed) — Samples Only
 L — Ceramic Sidebrazed
 P — Dual in-Line Plastic
 PNA — PQFN Power QFN
 PNB — PQFN Power QFN
 PNC — PQFN Power QFN
 PU — 14 x 14 mm Low-Profile Quad Flat Pack (LQFP)
 PV — 20 x 20 mm Low-Profile Quad Flat Pack (LQFP)
 S — Cerdip (windowed) — Samples Only
 TM — Mechatronics Connector
 VR — Plastic Ball Grid Array (PBGA) with PB-free solder balls
 ZP — 27 x 27 mm Plastic Ball Grid Array (PBGA)



— Pb-free —

AA — Pb-free 44 to 100 pin QFP

AB — Pb-free 112 to 288 pin QFP

AC — Pb-free 16 to 44 pin LQFP

AE — Pb-free 48 to 64 pin LQFP

AF — Pb-free 68 to 100 pin LQFP

AG — Pb-free 108 to 144 pin LQFP

AH — Pb-free 80 to 100 pin TQFP

AI — Pb-free FQFP

AJ — Pb-free CQFP

AE — Pb-free 22 to 64 pin PDIP

ED — Pb-free 6 to 20 pin PDIP

EE — Pb-free PSDIP

EF — Pb-free 8 to 16 in SOIC

EG — Pb-free 16 to 28 pin SOIC WIDE

EH — Pb-free 132 pin PQFP

EI — Pb-free PLCC

EJ — Pb-free 8 to 24 pin TSSOP

EK — Pb-free 32 to 54 pin SOIC WIDE

EL — Pb-free 26 to 56 pin TSSOP

EN — Pb-free 8 to 24 pin SSOP

EO — Pb-free 26 to 56 pin SSOP

EP — Pb-free QFN & MLF (Exposed Pad)

ER — Pb-free CATV

ES — Pb-free SENSOR

ET — Pb-free RF (POWER CHIPS)

EU — Pb-free MAC PAAC

EV — Pb-free MFP (SOEIAJ)

FC — Pb-free QFN & MLF (Regular)

FE — Pb-free CerQuads

VK — Pb-free MAPBGA $\leq 1.3\text{mm}$ (THINMAP) $< .7\text{mm}$ Pitch

VL — Pb-free MAPBGA $\leq 1.3\text{mm}$ (THINMAP) $> .7\text{mm}$ Pitch

VM — Pb-free MAPBGA 1.6mm $> .7\text{mm}$ Pitch

VN — Pb-free MAPBGA 1.6mm $< .7\text{mm}$ Pitch

VO — Pb-free MAPBGA 1.35mm $< .7\text{mm}$ Pitch

VP — Pb-free MAPBGA 1.36mm $> .7\text{mm}$ Pitch

VR — Pb-free PBGA

VS — Pb-free FC-HiTCE LGA (without C5 sphere)

VT — Pb-free FC PBGA

VU — Pb-free FC-HiTCE

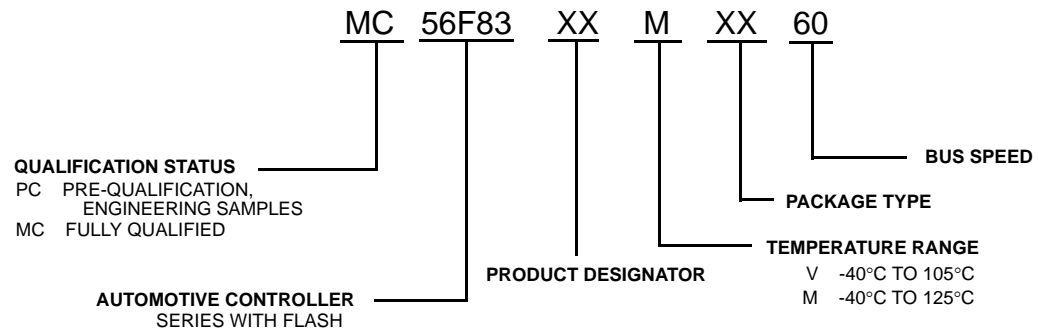
VV — Pb-free TBGA

VW — Pb-free HSOP

VX — Pb-free SMT

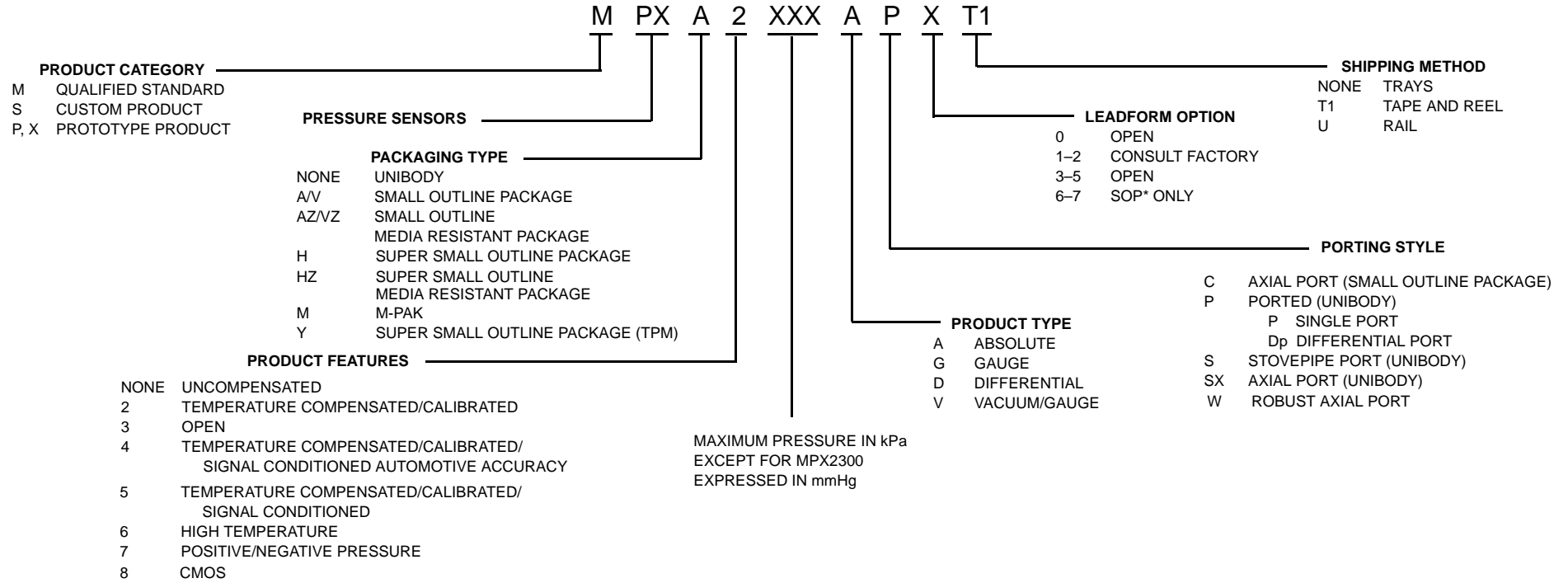
VY — Pb-free UNIBODY

Product Numbering System for MC56F8300 Digital Signal Controllers



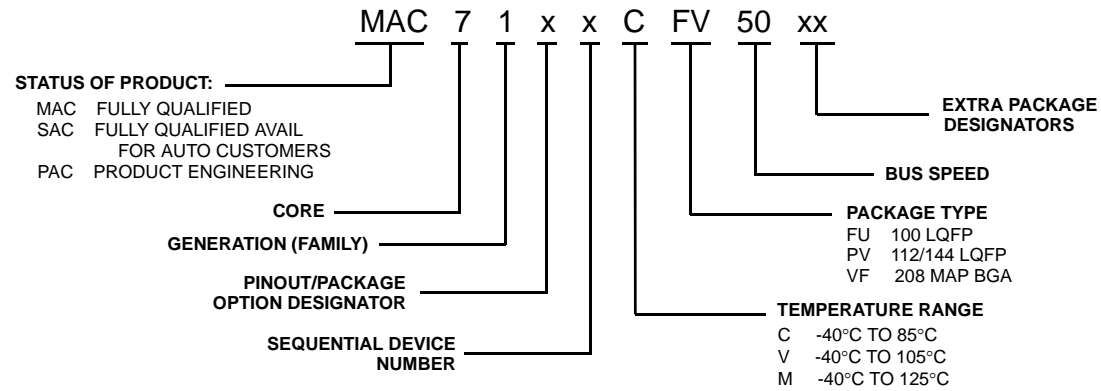


Product Numbering System for Pressure Sensors

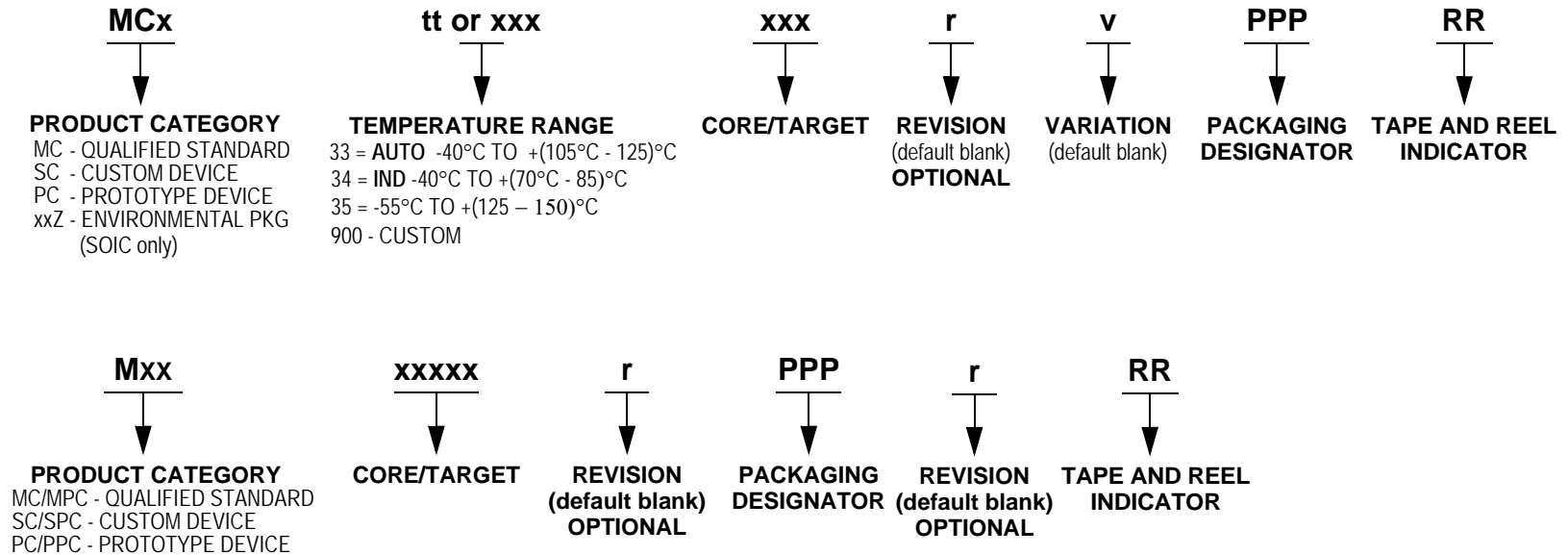




Product Numbering System for ARM Devices

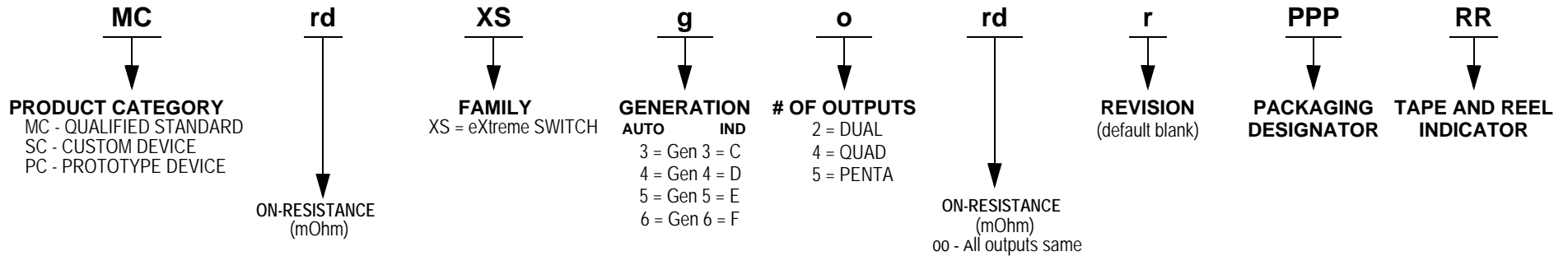


Product Numbering System for Analog and Power Management Devices

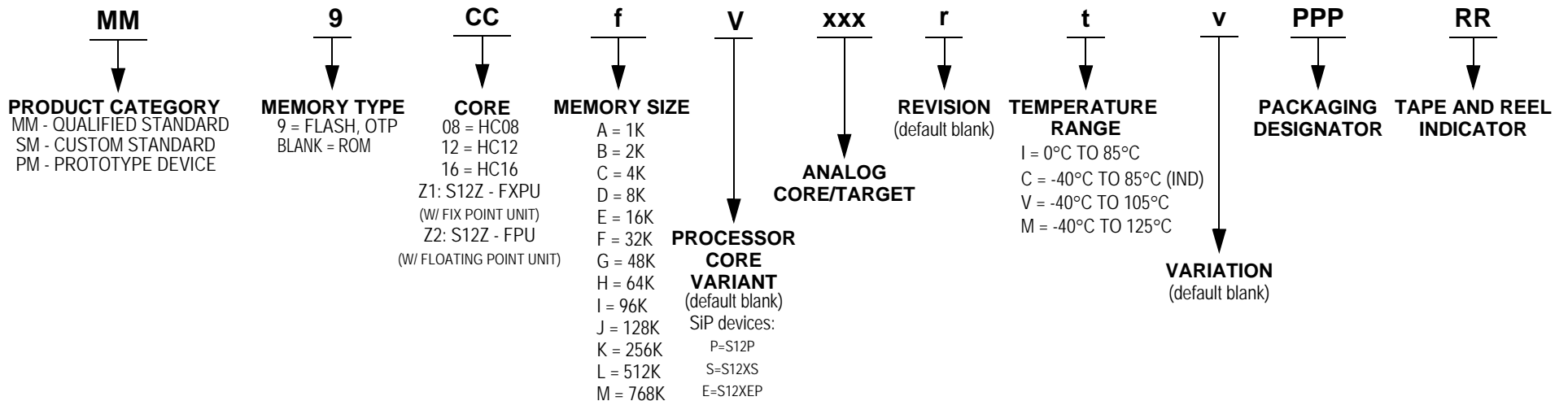




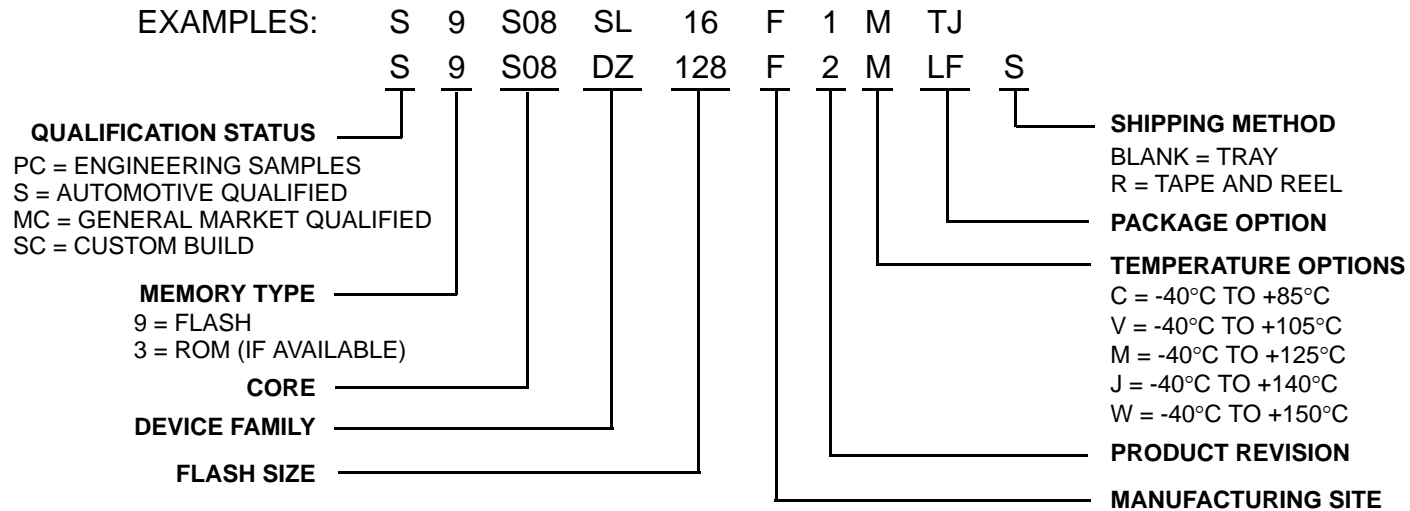
Product Numbering System for Analog eXtreme Switch Devices



Product Numbering System for Analog Embedded MCU + Power and SiP Devices

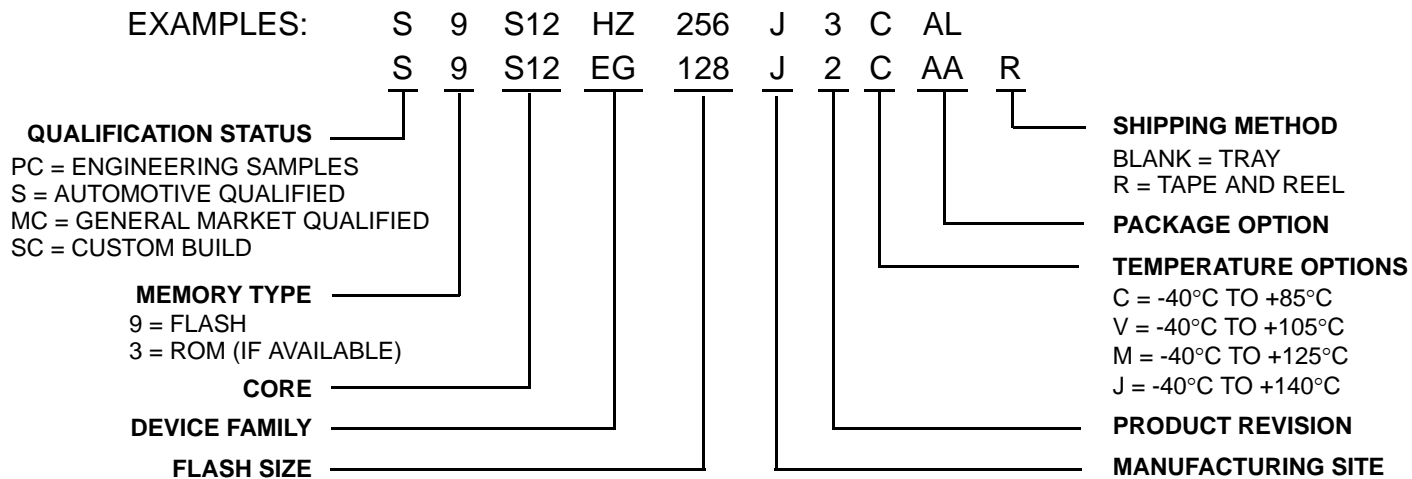


8-Bit Automotive Microcontroller Part Numbering System*



*NOTE: Freescale's automotive part numbering system has evolved over time, so the decoder scheme shown above may not be relevant for the prior generations.

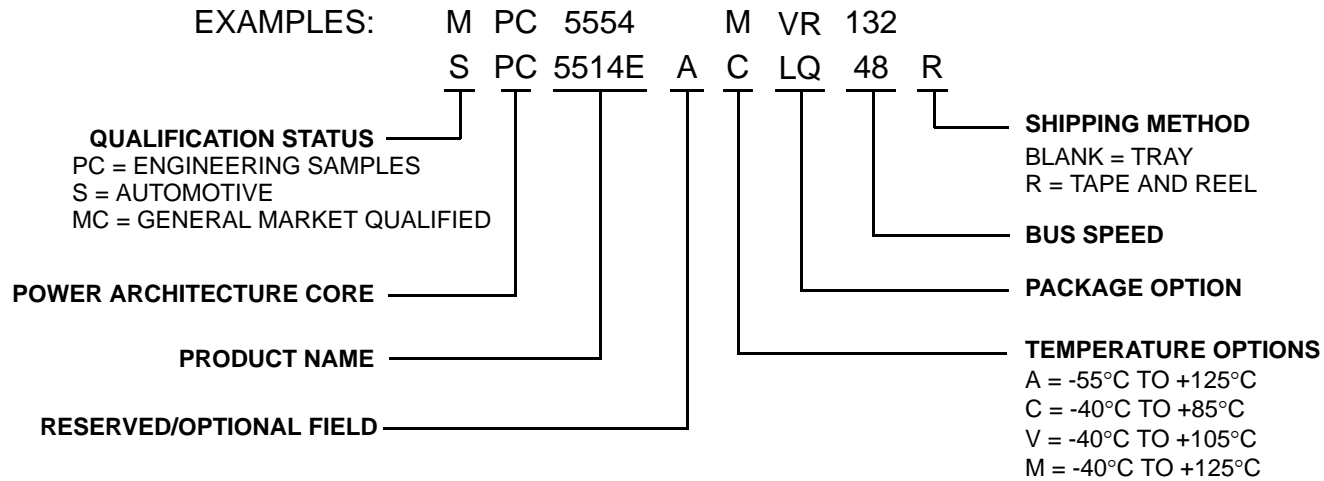
16-Bit Automotive Microcontroller Part Numbering System*



*NOTE: Freescale's automotive part numbering system has evolved over time, so the decoder scheme shown above may not be relevant for the prior generations.

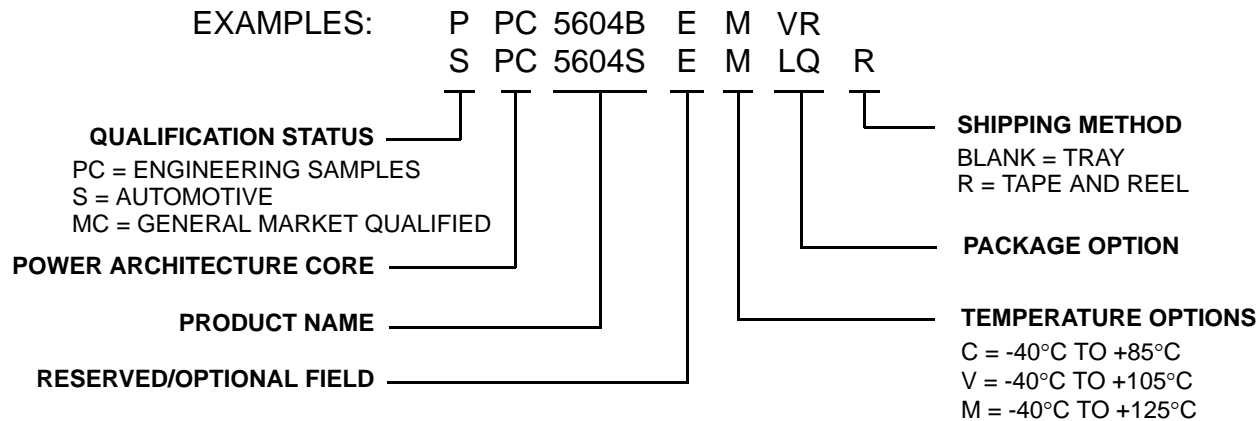


32-Bit Automotive Microcontroller Part Numbering System for Qorivva 55xx Devices*



*NOTE: Freescale's automotive part numbering system has evolved over time, so the decoder scheme shown above may not be relevant for the prior generations.

32-Bit Automotive Microcontroller Part Numbering System for Qorivva 56xx Devices*



*NOTE: Freescale's automotive part numbering system has evolved over time, so the decoder scheme shown above may not be relevant for the prior generations.



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